HP ProLiant DL320 G6 Server Maintenance and Service Guide

Abstract

This guide is for an experienced service technician. HP assumes you are qualified in the servicing of computer equipment and trained in recognizing hazards in products with hazardous energy levels and are familiar with weight and stability precautions for rack installation.

Contents

Customer self repair

HP products are designed with many Customer Self Repair (CSR) parts to minimize repair time and allow for greater flexibility in performing defective parts replacement. If during the diagnosis period HP (or HP service providers or service partners) identifies that the repair can be accomplished by the use of a CSR part, HP will ship that part directly to you for replacement. There are two categories of CSR parts:

- **Mandatory**—Parts for which customer self repair is mandatory. If you request HP to replace these parts, you will be charged for the travel and labor costs of this service.

- **Optional**—Parts for which customer self repair is optional. These parts are also designed for customer self repair. If, however, you require that HP replace them for you, there may or may not be additional charges, depending on the type of warranty service designated for your product.

NOTE: Some HP parts are not designed for customer self repair. In order to satisfy the customer warranty, HP requires that an authorized service provider replace the part. These parts are identified as "No" in the Illustrated Parts Catalog.

Based on availability and where geography permits, CSR parts will be shipped for next business day delivery. Same day or four-hour delivery may be offered at an additional charge where geography permits. If assistance is required, you can call the HP Technical Support Center and a technician will help you over the telephone. HP specifies in the materials shipped with a replacement CSR part whether a defective part must be returned to HP. In cases where it is required to return the defective part to HP, you must ship the defective part back to HP within a defined period of time, normally five (5) business days. The defective part must be returned with the associated documentation in the provided shipping material. Failure to return the defective part may result in HP billing you for the replacement. With a customer self repair, HP will pay all shipping and part return costs and determine the courier/carrier to be used.

For more information about HP's Customer Self Repair program, contact your local service provider. For the North American program, refer to the HP website (http://www.hp.com/go/selfrepair).

Parts only warranty service

Your HP Limited Warranty may include a parts only warranty service. Under the terms of parts only warranty service, HP will provide replacement parts free of charge.

For parts only warranty service, CSR part replacement is mandatory. If you request HP to replace these parts, you will be charged for the travel and labor costs of this service.

Réparation par le client (CSR)

Les produits HP comportent de nombreuses pièces CSR (Customer Self Repair = réparation par le client) afin de minimiser les délais de réparation et faciliter le remplacement des pièces défectueuses. Si pendant la période de diagnostic, HP (ou ses partenaires ou mainteneurs agréés) détermine que la réparation peut être effectuée à l'aide d'une pièce CSR, HP vous l'envoie directement. Il existe deux catégories de pièces CSR:

Obligatoire - Pièces pour lesquelles la réparation par le client est obligatoire. Si vous demandez à HP de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.

Facultatif - Pièces pour lesquelles la réparation par le client est facultative. Ces pièces sont également conçues pour permettre au client d'effectuer lui-même la réparation. Toutefois, si vous demandez à HP de remplacer ces pièces, l'intervention peut ou non vous être facturée, selon le type de garantie applicable à votre produit.

REMARQUE: Certaines pièces HP ne sont pas conçues pour permettre au client d'effectuer lui-même la réparation. Pour que la garantie puisse s'appliquer, HP exige que le remplacement de la pièce soit effectué par un Mainteneur Agréé. Ces pièces sont identifiées par la mention "Non" dans le Catalogue illustré.

Les pièces CSR sont livrées le jour ouvré suivant, dans la limite des stocks disponibles et selon votre situation géographique. Si votre situation géographique le permet et que vous demandez une livraison le jour même ou dans les 4 heures, celle-ci vous sera facturée. Pour bénéficier d'une assistance téléphonique, appelez le Centre d'assistance technique HP. Dans les documents envoyés avec la pièce de rechange CSR, HP précise s'il est nécessaire de lui retourner la pièce défectueuse. Si c'est le cas, vous devez le faire dans le délai indiqué, généralement cinq (5) jours ouvrés. La pièce et sa documentation doivent être retournées dans l'emballage fourni. Si vous ne retournez pas la pièce défectueuse, HP se réserve le droit de vous facturer les coûts de remplacement. Dans le cas d'une pièce CSR, HP supporte l'ensemble des frais d'expédition et de retour, et détermine la société de courses ou le transporteur à utiliser.

Pour plus d'informations sur le programme CSR de HP, contactez votre Mainteneur Agrée local. Pour plus d'informations sur ce programme en Amérique du Nord, consultez le site Web HP (http://www.hp.com/go/selfrepair).

Service de garantie "pièces seules"

Votre garantie limitée HP peut inclure un service de garantie "pièces seules". Dans ce cas, les pièces de rechange fournies par HP ne sont pas facturées.

Dans le cadre de ce service, la réparation des pièces CSR par le client est obligatoire. Si vous demandez à HP de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.

Riparazione da parte del cliente

Per abbreviare i tempi di riparazione e garantire una maggiore flessibilità nella sostituzione di parti difettose, i prodotti HP sono realizzati con numerosi componenti che possono essere riparati direttamente dal cliente (CSR, Customer Self Repair). Se in fase di diagnostica HP (o un centro di servizi o di assistenza HP) identifica il guasto come riparabile mediante un ricambio CSR, HP lo spedirà direttamente al cliente per la sostituzione. Vi sono due categorie di parti CSR:

Obbligatorie – Parti che devono essere necessariamente riparate dal cliente. Se il cliente ne affida la riparazione ad HP, deve sostenere le spese di spedizione e di manodopera per il servizio.

Opzionali – Parti la cui riparazione da parte del cliente è facoltativa. Si tratta comunque di componenti progettati per questo scopo. Se tuttavia il cliente ne richiede la sostituzione ad HP, potrebbe dover sostenere spese addizionali a seconda del tipo di garanzia previsto per il prodotto.

NOTA: alcuni componenti HP non sono progettati per la riparazione da parte del cliente. Per rispettare la garanzia, HP richiede che queste parti siano sostituite da un centro di assistenza autorizzato. Tali parti sono identificate da un "No" nel Catalogo illustrato dei componenti.

In base alla disponibilità e alla località geografica, le parti CSR vengono spedite con consegna entro il giorno lavorativo seguente. La consegna nel giorno stesso o entro quattro ore è offerta con un supplemento di costo solo in alcune zone. In caso di necessità si può richiedere l'assistenza telefonica di un addetto del centro di supporto tecnico HP. Nel materiale fornito con una parte di ricambio CSR, HP specifica se il cliente deve restituire dei componenti. Qualora sia richiesta la resa ad HP del componente difettoso, lo si deve spedire ad HP entro un determinato periodo di tempo, generalmente cinque (5) giorni lavorativi. Il componente difettoso deve essere restituito con la documentazione associata nell'imballo di spedizione fornito. La mancata restituzione del componente può comportare la fatturazione del ricambio da parte di HP. Nel caso di riparazione da parte del cliente, HP sostiene tutte le spese di spedizione e resa e sceglie il corriere/vettore da utilizzare.

Per ulteriori informazioni sul programma CSR di HP contattare il centro di assistenza di zona. Per il programma in Nord America fare riferimento al sito Web HP (http://www.hp.com/go/selfrepair).

Servizio di garanzia per i soli componenti

La garanzia limitata HP può includere un servizio di garanzia per i soli componenti. Nei termini di garanzia del servizio per i soli componenti, HP fornirà gratuitamente le parti di ricambio.

Per il servizio di garanzia per i soli componenti è obbligatoria la formula CSR che prevede la riparazione da parte del cliente. Se il cliente invece richiede la sostituzione ad HP, dovrà sostenere le spese di spedizione e di manodopera per il servizio.

Customer Self Repair

HP Produkte enthalten viele CSR-Teile (Customer Self Repair), um Reparaturzeiten zu minimieren und höhere Flexibilität beim Austausch defekter Bauteile zu ermöglichen. Wenn HP (oder ein HP Servicepartner) bei der Diagnose feststellt, dass das Produkt mithilfe eines CSR-Teils repariert werden kann, sendet Ihnen HP dieses Bauteil zum Austausch direkt zu. CSR-Teile werden in zwei Kategorien unterteilt:

Zwingend – Teile, für die das Customer Self Repair-Verfahren zwingend vorgegeben ist. Wenn Sie den Austausch dieser Teile von HP vornehmen lassen, werden Ihnen die Anfahrt- und Arbeitskosten für diesen Service berechnet.

Optional – Teile, für die das Customer Self Repair-Verfahren optional ist. Diese Teile sind auch für Customer Self Repair ausgelegt. Wenn Sie jedoch den Austausch dieser Teile von HP vornehmen lassen möchten, können bei diesem Service je nach den für Ihr Produkt vorgesehenen Garantiebedingungen zusätzliche Kosten anfallen.

HINWEIS: Einige Teile sind nicht für Customer Self Repair ausgelegt. Um den Garantieanspruch des Kunden zu erfüllen, muss das Teil von einem HP Servicepartner ersetzt werden. Im illustrierten Teilekatalog sind diese Teile mit „No" bzw. „Nein" gekennzeichnet.

CSR-Teile werden abhängig von der Verfügbarkeit und vom Lieferziel am folgenden Geschäftstag geliefert. Für bestimmte Standorte ist eine Lieferung am selben Tag oder innerhalb von vier Stunden gegen einen Aufpreis verfügbar. Wenn Sie Hilfe benötigen, können Sie das HP technische Support Center anrufen und sich von einem Mitarbeiter per Telefon helfen lassen. Den Materialien, die mit einem CSR-Ersatzteil geliefert werden, können Sie entnehmen, ob das defekte Teil an HP zurückgeschickt werden muss. Wenn es erforderlich ist, das defekte Teil an HP zurückzuschicken, müssen Sie dies innerhalb eines vorgegebenen Zeitraums tun, in der Regel innerhalb von fünf (5) Geschäftstagen. Das defekte Teil muss mit der zugehörigen Dokumentation in der Verpackung zurückgeschickt werden, die im Lieferumfang enthalten ist. Wenn Sie das

defekte Teil nicht zurückschicken, kann HP Ihnen das Ersatzteil in Rechnung stellen. Im Falle von Customer Self Repair kommt HP für alle Kosten für die Lieferung und Rücksendung auf und bestimmt den Kurier-/Frachtdienst.

Weitere Informationen über das HP Customer Self Repair Programm erhalten Sie von Ihrem Servicepartner vor Ort. Informationen über das CSR-Programm in Nordamerika finden Sie auf der HP Website unter (http://www.hp.com/go/selfrepair).

Parts-only Warranty Service (Garantieservice ausschließlich für Teile)

Ihre HP Garantie umfasst möglicherweise einen Parts-only Warranty Service (Garantieservice ausschließlich für Teile). Gemäß den Bestimmungen des Parts-only Warranty Service stellt HP Ersatzteile kostenlos zur Verfügung.

Für den Parts-only Warranty Service ist das CSR-Verfahren zwingend vorgegeben. Wenn Sie den Austausch dieser Teile von HP vornehmen lassen, werden Ihnen die Anfahrt- und Arbeitskosten für diesen Service berechnet.

Reparaciones del propio cliente

Los productos de HP incluyen muchos componentes que el propio usuario puede reemplazar (*Customer Self Repair*, CSR) para minimizar el tiempo de reparación y ofrecer una mayor flexibilidad a la hora de realizar sustituciones de componentes defectuosos. Si, durante la fase de diagnóstico, HP (o los proveedores o socios de servicio de HP) identifica que una reparación puede llevarse a cabo mediante el uso de un componente CSR, HP le enviará dicho componente directamente para que realice su sustitución. Los componentes CSR se clasifican en dos categorías:

- **Obligatorio:** componentes para los que la reparación por parte del usuario es obligatoria. Si solicita a HP que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.

- **Opcional:** componentes para los que la reparación por parte del usuario es opcional. Estos componentes también están diseñados para que puedan ser reparados por el usuario. Sin embargo, si precisa que HP realice su sustitución, puede o no conllevar costes adicionales, dependiendo del tipo de servicio de garantía correspondiente al producto.

NOTA: Algunos componentes no están diseñados para que puedan ser reparados por el usuario. Para que el usuario haga valer su garantía, HP pone como condición que un proveedor de servicios autorizado realice la sustitución de estos componentes. Dichos componentes se identifican con la palabra "No" en el catálogo ilustrado de componentes.

Según la disponibilidad y la situación geográfica, los componentes CSR se enviarán para que lleguen a su destino al siguiente día laborable. Si la situación geográfica lo permite, se puede solicitar la entrega en el mismo día o en cuatro horas con un coste adicional. Si precisa asistencia técnica, puede llamar al Centro de asistencia técnica de HP y recibirá ayuda telefónica por parte de un técnico. Con el envío de materiales para la sustitución de componentes CSR, HP especificará si los componentes defectuosos deberán devolverse a HP. En aquellos casos en los que sea necesario devolver algún componente a HP, deberá hacerlo en el periodo de tiempo especificado, normalmente cinco días laborables. Los componentes defectuosos deberán devolverse con toda la documentación relacionada y con el embalaje de envío. Si no

enviara el componente defectuoso requerido, HP podrá cobrarle por el de sustitución. En el caso de todas sustituciones que lleve a cabo el cliente, HP se hará cargo de todos los gastos de envío y devolución de componentes y escogerá la empresa de transporte que se utilice para dicho servicio.

Para obtener más información acerca del programa de Reparaciones del propio cliente de HP, póngase en contacto con su proveedor de servicios local. Si está interesado en el programa para Norteamérica, visite la página web de HP siguiente (http://www.hp.com/go/selfrepair).

Servicio de garantía exclusivo de componentes

La garantía limitada de HP puede que incluya un servicio de garantía exclusivo de componentes. Según las condiciones de este servicio exclusivo de componentes, HP le facilitará los componentes de repuesto sin cargo adicional alguno.

Para este servicio de garantía exclusivo de componentes, es obligatoria la sustitución de componentes por parte del usuario (CSR). Si solicita a HP que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.

Customer Self Repair

Veel onderdelen in HP producten zijn door de klant zelf te repareren, waardoor de reparatieduur tot een minimum beperkt kan blijven en de flexibiliteit in het vervangen van defecte onderdelen groter is. Deze onderdelen worden CSR-onderdelen (Customer Self Repair) genoemd. Als HP (of een HP Service Partner) bij de diagnose vaststelt dat de reparatie kan worden uitgevoerd met een CSR-onderdeel, verzendt HP dat onderdeel rechtstreeks naar u, zodat u het defecte onderdeel daarmee kunt vervangen. Er zijn twee categorieën CSR-onderdelen:

Verplicht: Onderdelen waarvoor reparatie door de klant verplicht is. Als u HP verzoekt deze onderdelen voor u te vervangen, worden u voor deze service reiskosten en arbeidsloon in rekening gebracht.

Optioneel: Onderdelen waarvoor reparatie door de klant optioneel is. Ook deze onderdelen zijn ontworpen voor reparatie door de klant. Als u echter HP verzoekt deze onderdelen voor u te vervangen, kunnen daarvoor extra kosten in rekening worden gebracht, afhankelijk van het type garantieservice voor het product.

OPMERKING: Sommige HP onderdelen zijn niet ontwikkeld voor reparatie door de klant. In verband met de garantievoorwaarden moet het onderdeel door een geautoriseerde Service Partner worden vervangen. Deze onderdelen worden in de geïllustreerde onderdelencatalogus aangemerkt met "Nee".

Afhankelijk van de leverbaarheid en de locatie worden CSR-onderdelen verzonden voor levering op de eerstvolgende werkdag. Levering op dezelfde dag of binnen vier uur kan tegen meerkosten worden aangeboden, indien dit mogelijk is gezien de locatie. Indien assistentie gewenst is, belt u een HP Service Partner om via de telefoon technische ondersteuning te ontvangen. HP vermeldt in de documentatie bij het vervangende CSR-onderdeel of het defecte onderdeel aan HP moet worden geretourneerd. Als het defecte onderdeel aan HP moet worden teruggezonden, moet u het defecte onderdeel binnen een bepaalde periode, gewoonlijk vijf (5) werkdagen, retourneren aan HP. Het defecte onderdeel moet met de bijbehorende documentatie worden geretourneerd in het meegeleverde verpakkingsmateriaal. Als u het defecte onderdeel niet terugzendt, kan HP u voor het vervangende onderdeel kosten in rekening brengen. Bij reparatie door de klant betaalt HP alle verzendkosten voor het vervangende en geretourneerde onderdeel en kiest HP zelf welke koerier/transportonderneming hiervoor wordt gebruikt.

Neem contact op met een Service Partner voor meer informatie over het Customer Self Repair programma van HP. Informatie over Service Partners vindt u op de HP website (http://www.hp.com/go/selfrepair).

Garantieservice "Parts Only"

Het is mogelijk dat de HP garantie alleen de garantieservice "Parts Only" omvat. Volgens de bepalingen van de Parts Only garantieservice zal HP kosteloos vervangende onderdelen ter beschikking stellen.

Voor de Parts Only garantieservice is vervanging door CSR-onderdelen verplicht. Als u HP verzoekt deze onderdelen voor u te vervangen, worden u voor deze service reiskosten en arbeidsloon in rekening gebracht.

Reparo feito pelo cliente

Os produtos da HP são projetados com muitas peças para reparo feito pelo cliente (CSR) de modo a minimizar o tempo de reparo e permitir maior flexibilidade na substituição de peças com defeito. Se, durante o período de diagnóstico, a HP (ou fornecedores/parceiros de serviço da HP) concluir que o reparo pode ser efetuado pelo uso de uma peça CSR, a peça de reposição será enviada diretamente ao cliente. Existem duas categorias de peças CSR:

Obrigatória – Peças cujo reparo feito pelo cliente é obrigatório. Se desejar que a HP substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

Opcional – Peças cujo reparo feito pelo cliente é opcional. Essas peças também são projetadas para o reparo feito pelo cliente. No entanto, se desejar que a HP as substitua, pode haver ou não a cobrança de taxa adicional, dependendo do tipo de serviço de garantia destinado ao produto.

OBSERVAÇÃO: Algumas peças da HP não são projetadas para o reparo feito pelo cliente. A fim de cumprir a garantia do cliente, a HP exige que um técnico autorizado substitua a peça. Essas peças estão identificadas com a marca "No" (Não), no catálogo de peças ilustrado.

Conforme a disponibilidade e o local geográfico, as peças CSR serão enviadas no primeiro dia útil após o pedido. Onde as condições geográficas permitirem, a entrega no mesmo dia ou em quatro horas pode ser feita mediante uma taxa adicional. Se precisar de auxílio, entre em contato com o Centro de suporte técnico da HP para que um técnico o ajude por telefone. A HP especifica nos materiais fornecidos com a peça CSR de reposição se a peça com defeito deve ser devolvida à HP. Nos casos em que isso for necessário, é preciso enviar a peça com defeito à HP dentro do período determinado, normalmente cinco (5) dias úteis. A peça com defeito deve ser enviada com a documentação correspondente no material de transporte fornecido. Caso não o faça, a HP poderá cobrar a reposição. Para as peças de reparo feito pelo cliente, a HP paga todas as despesas de transporte e de devolução da peça e determina a transportadora/serviço postal a ser utilizado.

Para obter mais informações sobre o programa de reparo feito pelo cliente da HP, entre em contato com o fornecedor de serviços local. Para o programa norte-americano,   visite o site da HP (http://www.hp.com/go/selfrepair).

Serviço de garantia apenas para peças

A garantia limitada da HP pode incluir um serviço de garantia apenas para peças. Segundo os termos do serviço de garantia apenas para peças, a HP fornece as peças de reposição sem cobrar nenhuma taxa.

No caso desse serviço, a substituição de peças CSR é obrigatória. Se desejar que a HP substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

顧客自己修理保証サービス

修理時間を短縮し、故障部品の交換における高い柔軟性を確保するために、HP製品には多数の顧客自己修理（CSR）部品があります。診断の際に、CSR部品を使用すれば修理ができるとHP（HPまたはHP正規保守代理店）が判断した場合、HPはその部品を直接、お客様に発送し、お客様に交換していただきます。CSR部品には以下の2通りがあります。

- 必須 - 顧客自己修理が必須の部品。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費がお客様に請求されます。
- 任意 - 顧客自己修理が任意である部品。この部品も顧客自己修理用です。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、お買い上げの製品に適用される保証サービス内容の範囲内においては、別途費用を負担していただくことなく保証サービスを受けることができます。

注: HP製品の一部の部品は、顧客自己修理用ではありません。製品の保証を継続するためには、HPまたはHP正規保守代理店による交換作業が必須となります。部品カタログには、当該部品が顧客自己修理除外品である旨が記載されています。

部品供給が可能な場合、地域によっては、CSR部品を翌営業日に届くように発送します。また、地域によっては、追加費用を負担いただくことにより同日または4時間以内に届くように発送することも可能な場合があります。サポートが必要なときは、HPの修理受付窓口に電話していただければ、技術者が電話でアドバイスします。交換用のCSR部品または同梱物には、故障部品をHPに返送する必要があるかどうかが表示されています。故障部品をHPに返送する必要がある場合は、指定期限内（通常は5営業日以内）に故障部品をHPに返送してください。故障部品を返送する場合は、届いた時の梱包箱に関連書類とともに入れてください。故障部品を返送しない場合、HPから部品費用が請求されます。顧客自己修理の際には、HPは送料および部品返送費を全額負担し、使用する宅配便会社や運送会社を指定します。

部品のみ保証サービス

HP保証サービスには、部品のみ保証サービスが適用される場合があります。このサービスでは、交換部品は無償で提供されます。

部品のみ保証サービスにおいては、CSR部品をお客様により交換作業していただくことが必須となります。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費はお客様の負担となります。

客户自行维修

HP 产品提供许多客户自行维修 (CSR) 部件，以尽可能缩短维修时间和在更换缺陷部件方面提供更大的灵活性。如果在诊断期间 HP（或 HP 服务提供商或服务合作伙伴）确定可以通过使用 CSR 部件完成维修，HP 将直接把该部件发送给您进行更换。有两类 CSR 部件：

- **强制性的** — 要求客户必须自行维修的部件。如果您请求 HP 更换这些部件，则必须为该服务支付差旅费和人工费用。
- **可选的** — 客户可以选择是否自行维修的部件。这些部件也是为客户自行维修设计的。不过，如果您要求 HP 为您更换这些部件，则根据为您的产品指定的保修服务类型，HP 可能收取或不再收取任何附加费用。

注：某些 HP 部件的设计并未考虑客户自行维修。为了满足客户保修的需要，HP 要求授权服务提供商更换相关部件。这些部件在部件图解目录中标记为"否"。

CSR 部件将在下一个工作日发运（取决于备货情况和允许的地理范围）。在允许的地理范围内，可在当天或四小时内发运，但要收取额外费用。如果需要帮助，您可以致电 HP 技术支持中心，将会有技术人员通过电话为您提供帮助。HP 会在随更换的 CSR 部件发运的材料中指明是否必须将有缺陷的部件返还给 HP。如果要求您将有缺陷的部件返还给 HP，那么您必须在规定期限内（通常是五 (5) 个工作日）将缺陷部件发给 HP。有缺陷的部件必须随所提供的发运材料中的相关文件一起返还。如果未能送还有缺陷的部件，HP 可能会要求您支付更换费用。客户自行维修时，HP 将承担所有相关运输和部件返回费用，并指定快递商/承运商。

有关 HP 客户自行维修计划的详细信息，请与您当地的服务提供商联系。有关北美地区的计划，请访问 HP 网站 (http://www.hp.com/go/selfrepair)。

仅部件保修服务

您的 HP 有限保修服务可能涉及仅部件保修服务。根据仅部件保修服务条款的规定，HP 将免费提供更换的部件。

仅部件保修服务要求进行 CSR 部件更换。如果您请求 HP 更换这些部件，则必须为该服务支付差旅费和人工费用。

客戶自行維修

HP 產品設計了許多「客戶自行維修」(CSR) 的零件以減少維修時間，並且使得更換瑕疵零件時能有更大的彈性。如果在診斷期間 HP（或 HP 服務供應商或維修夥伴）辨認出此項維修工作可以藉由使用 CSR 零件來完成，則 HP 將直接寄送該零件給您作更換。CSR 零件分為兩種類別：

- **強制的** — 客戶自行維修所使用的零件是強制性的。如果您要求 HP 更換這些零件，HP 將會向您收取此服務所需的外出費用與勞動成本。

- **選購的** — 客戶自行維修所使用的零件是選購的。這些零件也設計用於客戶自行維修之用。不過，如果您要求 HP 為您更換，則可能需要也可能不需要負擔額外的費用，端視針對此產品指定的保固服務類型而定。

備註： 某些 HP 零件沒有消費者可自行維修的設計。為符合客戶保固，HP 需要授權的服務供應商更換零件。這些零件在圖示的零件目錄中，被標示為「否」。

基於材料取得及環境允許的情況下，CSR 零件將於下一個工作日以快遞寄送。在環境的允許下當天或四小時內送達，則可能需要額外的費用。若您需要協助，可致電「HP 技術支援中心」，會有一位技術人員透過電話來協助您。不論損壞的零件是否必須退回，HP 皆會在與 CSR 替換零件一起運送的材料中註明。若要將損壞的零件退回 HP，您必須在指定的一段時間內（通常為五 (5) 個工作天），將損壞的零件寄回 HP。損壞的零件必須與寄送資料中隨附的相關技術文件一併退還。如果無法退還損壞的零件，HP 可能要向您收取替換費用。針對客戶自行維修情形，HP 將負責所有運費及零件退還費用並指定使用何家快遞/貨運公司。

如需 HP 的「客戶自行維修」方案詳細資訊，請連絡您當地的服務供應商。至於北美方案，請參閱 HP 網站 (http://www.hp.com/go/selfrepair)。

僅限零件的保固服務

您的「HP 有限保固」可能包含僅限零件的保固服務。在僅限零件的保固服務情況下，HP 將免費提供替換零件。

針對僅限零件的保固服務，CSR 零件替換是強制性的。如果您要求 HP 更換這些零件，HP 將會向您收取此服務所需的外出費用與勞動成本。

고객 셀프 수리

HP 제품은 수리 시간을 최소화하고 결함이 있는 부품 교체 시 더욱 융통성을 발휘할 수 있도록 하기 위해 고객 셀프 수리(CSR) 부품을 다량 사용하여 설계되었습니다. 진단 기간 동안 HP(또는 HP 서비스 공급업체 또는 서비스 협력업체)에서 CSR 부품을 사용하여 수리가 가능하다고 판단되면 HP는 해당 부품을 바로 사용자에게 보내어 사용자가 교체할 수 있도록 합니다. CSR 부품에는 두 가지 종류가 있습니다.

- **고객 셀프 수리가 의무 사항인 필수 부품.** 사용자가 HP에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.
- **고객 셀프 수리가 선택 사항인 부품.** 이 부품들도 고객 셀프 수리가 가능하도록 설계되었습니다. 하지만 사용자가 HP에 이 부품의 교체를 요청할 경우 사용자가 구입한 제품에 해당하는 보증 서비스 유형에 따라 추가 비용 없이 교체가 가능할 수 있습니다.

참고: 일부 HP 부품은 고객 셀프 수리가 불가능하도록 설계되었습니다. HP는 만족스러운 고객 보증을 위해 공인 서비스 제공업체를 통해 부품을 교체하도록 하고 있습니다. 이러한 부품들은 Illustrated Parts Catalog에 "No"라고 표시되어 있습니다.

CSR 부품은 재고 상태와 지리적 조건이 허용하는 경우 다음 영업일 납품이 가능하도록 배송이 이루어집니다. 지리적 조건이 허용하는 경우 추가 비용이 청구되는 조건으로 당일 또는 4시간 배송이 가능할 수도 있습니다. 도움이 필요하시면 HP 기술 지원 센터로 전화하십시오. 전문 기술자가 전화로 도움을 줄 것입니다. HP는 결함이 발생한 부품을 HP로 반환해야 하는지 여부를 CSR 교체 부품과 함께 배송된 자료에 지정합니다. 결함이 발생한 부품을 HP로 반환해야 하는 경우에는 지정된 기간 내(통상 영업일 기준 5일)에 HP로 반환해야 합니다. 이 때 결함이 발생한 부품은 제공된 포장 재료에 넣어 관련 설명서와 함께 반환해야 합니다. 결함이 발생한 부품을 반환하지 않는 경우 HP가 교체 부품에 대해 비용을 청구할 수 있습니다. 고객 셀프 수리의 경우, HP는 모든 운송 및 부품 반환 비용을 부담하며 이용할 운송업체 및 택배 서비스를 결정합니다.

HP 고객 셀프 수리 프로그램에 대한 자세한 내용은 가까운 서비스 제공업체에 문의하십시오. 북미 지역의 프로그램에 대해서는 HP 웹 사이트(http://www.hp.com/go/selfrepair)를 참조하십시오.

부품 제공 보증 서비스

HP 제한 보증에는 부품 제공 보증 서비스가 포함될 수 있습니다. 이러한 경우 HP는 부품 제공 보증 서비스의 조건에 따라 교체 부품만을 무료로 제공합니다.

부품 제공 보증 서비스 제공 시 CSR 부품 교체는 의무 사항입니다. 사용자가 HP에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.

Illustrated parts catalog

Server components
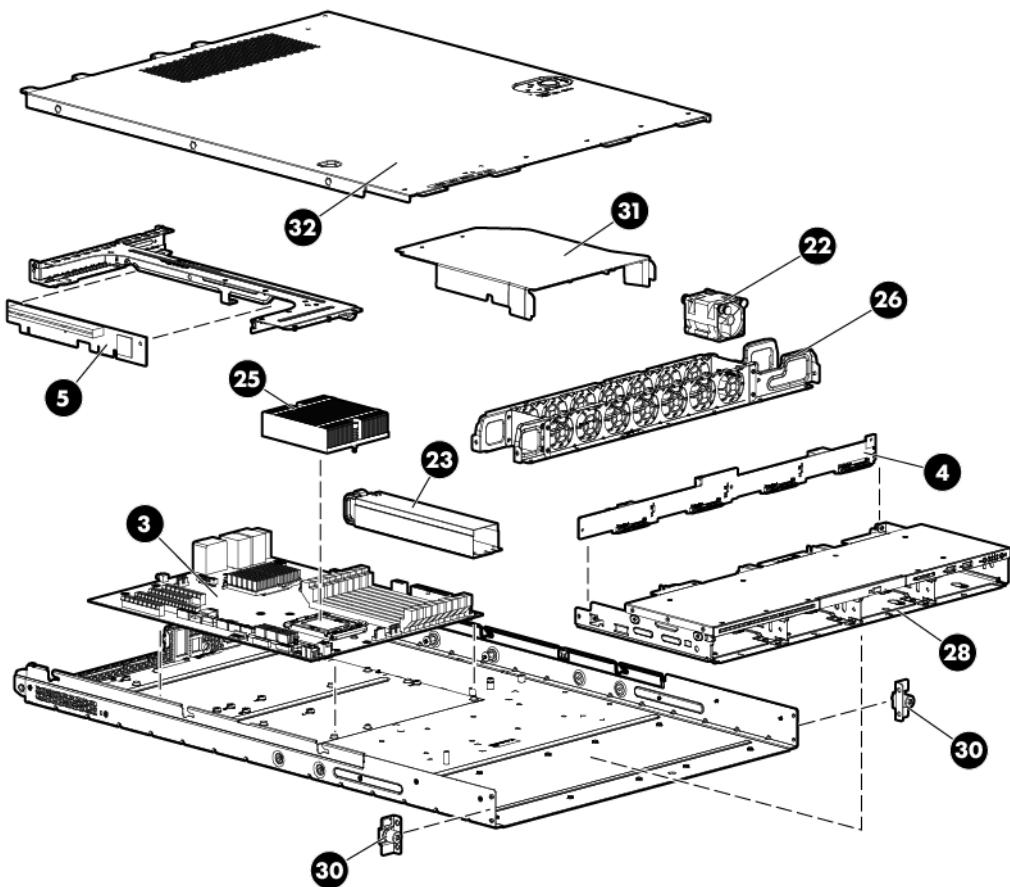
Item	Description	Spare part number	Customer self repair (on page 5)
1	Processors*	—	—
	a) 1.60-GHz Intel® Xeon® E5603 processor	628700-001	Optional[2]
	b) 1.86-GHz Intel® Xeon® E5502 processor	490075-001	Optional[2]
	c) 1.86-GHz Intel® Xeon® L5609 processor	594892-001	Optional[2]
	d) 2.00-GHz Intel® Xeon® E5503 processor	594889-001	Optional[2]
	e) 2.00-GHz Intel® Xeon® E5504 processor	490074-001	Optional[2]
	f) 2.13-GHz Intel® Xeon® E5506 processor	506013-001	Optional[2]

Item	Description	Spare part number	Customer self repair (on page 5)
	g) 2.13-GHz Intel® Xeon® L5506 processor	511041-001	Optional[2]
	h) 2.13-GHz Intel® Xeon® E5606 processor	628699-001	Optional[2]
	i) 2.13-GHz Intel® Xeon® L5630 processor	594891-001	Optional[2]
	j) 2.26-Ghz Intel® Xeon® E5607 processor	628698-001	Optional[2]
	k) 2.26-GHz Intel® Xeon® E5520 processor	490073-001	Optional[2]
	l) 2.26-GHz Intel® Xeon® L5520 processor	508567-001	Optional[2]
	m) 2.40-GHz Intel® Xeon® E5530 processor	490072-001	Optional[2]
	n) 2.40-GHz Intel® Xeon® E5620 processor	594887-001	Optional[2]
	o) 2.50-GHz Intel® Xeon® E5645 processor	628696-001	Optional[2]
	p) 2.53-GHz Intel® Xeon® E5630 processor	594886-001	Optional[2]
	q) 2.53-GHz Intel® Xeon® E5649 processor	628695-001	Optional[2]
	r) 2.53-GHz Intel® Xeon® E5540 processor	490071-001	Optional[2]
	s) 2.66-GHz Intel® Xeon® E5640 processor	594885-001	Optional[2]
	t) 2.66-GHz Intel® Xeon® X5650 processor	594884-001	Optional[2]
	u) 2.66-GHz Intel® Xeon® W3520 processor	612164-001	Optional[2]
	v) 3.06-GHz Intel® Xeon® W3550 processor	612165-001	Optional[2]
2	DIMMs*	—	—
	a) PC3-10600R (DDR3) 2-GB RDIMM	501533-001	Mandatory[1]
	b) PC3-10600R (DDR3) 4-GB RDIMM	501534-001	Mandatory[1]
	c) PC3-10600R (DDR3) 4-GB RDIMM	595424-001	Mandatory[1]
	d) PC3-10600R (DDR3) 8-GB RDIMM	501536-001	Mandatory[1]
	e) PC3L-10600R-9 (DDR3) 16-GB RDIMM	632204-001	Mandatory[1]
	f) PC3-8500R (DDR3) 16-GB RDIMM	501538-001	Mandatory[1]
	g) Low-Voltage PC3-8500R (DDR3) 4-GB RDIMM**	595422-001	Mandatory[1]
	h) Low-Voltage PC3-8500R (DDR3) 8-GB RDIMM**	595423-001	Mandatory[1]
	i) PC3-10600E (DDR3) 1-GB UDIMM	501539-001	Mandatory[1]
	j) PC3-10600E (DDR3) 2-GB UDIMM	501540-001	Mandatory[1]
	k) PC3-10600E (DDR3) 4-GB UDIMM	501541-001	Mandatory[1]
	Boards		
3	System board	610524-001	Optional[2]
4	Backplanes	—	—
	a) SFF SAS/SATA backplane	536394-001	Optional[2]
	b) LFF SAS/SATA backplane*	536395-001	Optional[2]
	c) Power supply backplane*	536406-001	Optional[2]

Item	Description	Spare part number	Customer self repair (on page 5)
	d) Redundant power supply backplane with cage*	532479-001	Optional[2]
5	PCI riser boards	—	—
	a) PCIe x16 (x16 link)	511808-001	Optional[2]
	b) PCIe x16 (x4 link)*	511809-001	Optional[2]
	c) PCI-X*	536393-001	Optional[2]
6	Dedicated iLO 2 connector module*	575058-001	Optional[2]
7	Cache module*	462974-001	Optional[2]
8	Trusted Platform Module*	505836-001	No[3]
	Mass storage devices		
9	Optical drives*	—	—
	a) SATA DVD-ROM drive, 9.5-mm	481430-001	Mandatory[1]
	b) SATA DVD-R/W drive, 9.5-mm	481431-001	Mandatory[1]
10	LFF SATA hard drives*	—	—
	a) 80-GB, 7200-rpm, hot-plug	397551-001	Mandatory[1]
	b) 160-GB, 7200-rpm, hot-plug	397552-001	Mandatory[1]
	c) 160-GB, 7200-rpm, hot-plug, NCQ	483095-001	Mandatory[1]
	d) 250-GB, 7200-rpm, hot-plug	397553-001	Mandatory[1]
	e) 250-GB, 7200-rpm, hot-plug, NCQ	459318-001	Mandatory[1]
	f) 500-GB, 7200-rpm, hot-plug	395501-001	Mandatory[1]
	g) 500-GB, 7200-rpm, hot-plug	495319-001	Mandatory[1]
	h) 750-GB, 7200-rpm, hot-plug, NCQ	432401-001	Mandatory[1]
	i) 750-GB, 7200-rpm, hot-plug, 3G, NCQ	459320-001	Mandatory[1]
	j) 1-TB, 7200-rpm, hot-plug, 3G, NCQ	454273-001	Mandatory[1]
	k) 2-TB, 7200-rpm, hot-plug, 3G, NCQ	508040-001	Mandatory[1]
11	LFF SAS hard drives*	—	—
	a) 72-GB, 15,000-rpm, hot-plug	376594-001	Mandatory[1]
	b) 72-GB, 15,000-rpm, hot-plug, dual-port	389343-001	Mandatory[1]
	c) 146-GB, 15,000-rpm, hot-plug	376595-001	Mandatory[1]
	d) 146-GB, 15,000-rpm, hot-plug, dual-port	389344-001	Mandatory[1]
	e) 300-GB, 15,000-rpm, hot-plug, dual-port	416248-001	Mandatory[1]
	f) 300-GB, 15,000-rpm, hot-plug, dual-port	432146-001	Mandatory[1]
	g) 400-GB, 10,000-rpm, hot-plug	456896-001	Mandatory[1]
	h) 450-GB, 15,000-rpm, hot-plug, dual-port	454274-001	Mandatory[1]
	i) 750-GB, 15,000-rpm, hot-plug	461288-001	Mandatory[1]
	j) 1-TB, 15,000-rpm, hot-plug	461289-001	Mandatory[1]

Item	Description	Spare part number	Customer self repair (on page 5)
	k) 1-TB, 7200-rpm, hot-plug	508011-001	Mandatory[1]
	l) 2-TB, 7200-rpm, hot-plug	508010-001	Mandatory[1]
	m) 300-GB, 6G/s	586875-001	Mandatory[1]
	n) 450-GB, 6G/s	586876-001	Mandatory[1]
	o) 600-GB, 6G/s	586877-001	Mandatory[1]
	p) 1-TB, 6G/s	601884-001	Mandatory[1]
	q) 2-TB, 6G/s	601883-001	Mandatory[1]
12	SFF SATA hard drives*	—	—
	a) 120-GB, 5400-rpm	459616-001	Mandatory[1]
	b) 160-GB, 5400-rpm	390158-018	Mandatory[1]
	c) 500-GB, 5400-rpm	390158-016	Mandatory[1]
	d) 60-GB, 5400-rpm, 1.5G, hot-plug	405419-001	Mandatory[1]
	e) 120-GB, 5400-rpm, 1.5G, hot-plug	431908-001	Mandatory[1]
	f) 120-GB, 5400-rpm, hot-plug	459322-001	Mandatory[1]
	g) 250-GB, 5400-rpm, hot-plug	460427-001	Mandatory[1]
	h) 36-GB, SSD	461332-001	Mandatory[1]
	i) 64-GB, SSD	461333-001	Mandatory[1]
13	SFF SAS hard drives*	—	—
	a) 36-GB, 10,000-rpm, hot-plug, 3G	376596-001	Mandatory[1]
	b) 36-GB, 15,000-rpm, hot-plug, dual-port, 3G	418397-001	Mandatory[1]
	c) 36-GB, 15,000-rpm, hot-plug, 3G	432322-001	Mandatory[1]
	d) 72-GB, 10,000-rpm, hot-plug, 3G	434916-001	Mandatory[1]
	e) 72-GB, 10,000-rpm, hot-plug, dual-port	389346-001	Mandatory[1]
	f) 72-GB, 15,000-rpm, hot-plug, dual-port	418398-001	Mandatory[1]
	g) 72-GB, 10,000-rpm, hot-plug, dual-port, 3G	389346-001	Mandatory[1]
	h) 72-GB, 15,000-rpm, hot-plug, 3G	432321-001	Mandatory[1]
	i) 146-GB, 10,000-rpm, hot-plug, dual-port	418399-001	Mandatory[1]
	j) 146-GB, 10,000-rpm, hot-plug, 3G	432320-001	Mandatory[1]
	k) 146-GB, 10,000-rpm, hot-plug, dual-port, 6G	507283-001	Mandatory[1]
	l) 300-GB, 10,000-rpm, hot-plug, dual-port	493083-001	Mandatory[1]
	m) 300-GB, 10,000-rpm, hot-plug, dual-port, 6G	507284-001	Mandatory[1]
	n) 72-GB 6GB/s, 15,000-rpm	586871-001	Mandatory[1]
	o) 146-GB 6GB/s, 10,000-rpm	507129-002	Mandatory[1]
	p) 146-GB 6GB/s, 15,000-rpm	507129-010	Mandatory[1]

Item	Description	Spare part number	Customer self repair (on page 5)
	q) 300-GB 6GB/s, 10,000-rpm	507129-004	Mandatory[1]
	r) 450-GB 6GB/s, 10,000-rpm	507129-012	Mandatory[1]
	s) 500-GB 6GB/s, 7,200-rpm	507129-006	Mandatory[1]
	t) 600-GB 6GB/s, 10,000-rpm	507129-014	Mandatory[1]
14	SATA Midline (MDL) Solid State Drives*	—	—
	a) 60-GB, hot-plug	539557-008	Mandatory[1]
	b) 120-GB, hot-plug	539557-010	Mandatory[1]
	Cables		
15	SATA power and data cable*	536398-001	Mandatory[1]
16	Mini-SAS to SATA cable*	536396-001	Mandatory[1]
17	Hard drive backplane sensor data cable*	536399-001	Mandatory[1]
18	Power cord*	142258-001	Mandatory[1]
19	8-to-4-pin extension cable*	613231-001	Mandatory[1]
20	4-pin extension cable*	613232-001	Mandatory[1]
	Miscellaneous		
21	Slimline optical drive bracket*	532475-001	Mandatory[1]
22	Fan	536401-001	Mandatory[1]
23	Power supplies	—	—
	a) Power supply, 500-W	506247-001	Optional[2]
	b) Power supply, 460-W*	536404-001	Optional[2]
	c) Power supply, 400-W*	536403-001	Optional[2]
	d) Redundant power supply, 400-W*	532478-001	Optional[2]
24	Power supply bracket*	532473-001	Mandatory[1]
25	Processor heatsink	536392-001	Optional[2]
26	Fan clip	536402-001	Optional[2]
27	System PSU cable clip*	613233-001	Optional[2]
28	LFF hard drive cage (with backplane)	532114-001	Optional[2]
29	SFF hard drive cage (with backplane)*	536400-001	Optional[2]
30	Rack mounting tabs (2)	536407-001	Optional[2]
31	Air baffle	572968-001	Mandatory[1]
32	Access panel	507262-001	Mandatory[1]
33	System battery*	234556-001	Mandatory[1]
34	Cache battery*	398648-001	Mandatory[1]
35	Capacitor pack*	587324-001	Mandatory[1]
36	Rack rail kit*	573091-001	Mandatory[1]

*Not shown
** If LVDIMMs are mixed with standard DDR3 DIMMs on the same server, the LVDIMMs operate at 1.5V. If there are three LVDIMMs per channel, the LVDIMMs operate at 1.5V. LVDIMMs are only supported for use with the Intel® Xeon® 5600 series of processors.

[1]Mandatory—Parts for which customer self repair is mandatory. If you request HP to replace these parts, you will be charged for the travel and labor costs of this service.

[2]Optional—Parts for which customer self repair is optional. These parts are also designed for customer self repair. If, however, you require that HP replace them for you, there may or may not be additional charges, depending on the type of warranty service designated for your product.

[3]No—Some HP parts are not designed for customer self repair. In order to satisfy the customer warranty, HP requires that an authorized service provider replace the part. These parts are identified as "No" in the Illustrated Parts Catalog.

[1]Mandatory: Obligatoire—Pièces pour lesquelles la réparation par le client est obligatoire. Si vous demandez à HP de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.

[2]Optional: Facultatif—Pièces pour lesquelles la réparation par le client est facultative. Ces pièces sont également conçues pour permettre au client d'effectuer lui-même la réparation. Toutefois, si vous demandez à HP de remplacer ces pièces, l'intervention peut ou non vous être facturée, selon le type de garantie applicable à votre produit.

[3]No: Non—Certaines pièces HP ne sont pas conçues pour permettre au client d'effectuer lui-même la réparation. Pour que la garantie puisse s'appliquer, HP exige que le remplacement de la pièce soit effectué par un Mainteneur Agréé. Ces pièces sont identifiées par la mention "Non" dans le Catalogue illustré.

[1]Mandatory: Obbligatorie—Parti che devono essere necessariamente riparate dal cliente. Se il cliente ne affida la riparazione ad HP, deve sostenere le spese di spedizione e di manodopera per il servizio.

[2]Optional: Opzionali—Parti la cui riparazione da parte del cliente è facoltativa. Si tratta comunque di componenti progettati per questo scopo. Se tuttavia il cliente ne richiede la sostituzione ad HP, potrebbe dover sostenere spese addizionali a seconda del tipo di garanzia previsto per il prodotto.

[3]No: Non CSR—Alcuni componenti HP non sono progettati per la riparazione da parte del cliente. Per rispettare la garanzia, HP richiede che queste parti siano sostituite da un centro di assistenza autorizzato. Tali parti sono identificate da un "No" nel Catalogo illustrato dei componenti.

[1]Mandatory: Zwingend—Teile, die im Rahmen des Customer Self Repair Programms ersetzt werden müssen. Wenn Sie diese Teile von HP ersetzen lassen, werden Ihnen die Versand- und Arbeitskosten für diesen Service berechnet.

[2]Optional: Optional—Teile, für die das Customer Self Repair-Verfahren optional ist. Diese Teile sind auch für Customer Self Repair ausgelegt. Wenn Sie jedoch den Austausch dieser Teile von HP vornehmen lassen möchten, können bei diesem Service je nach den für Ihr Produkt vorgesehenen Garantiebedingungen zusätzliche Kosten anfallen.

[3]No: Kein—Einige Teile sind nicht für Customer Self Repair ausgelegt. Um den Garantieanspruch des Kunden zu erfüllen, muss das Teil von einem HP Servicepartner ersetzt werden. Im illustrierten Teilekatalog sind diese Teile mit „No" bzw. „Nein" gekennzeichnet.

[1]Mandatory: Obligatorio—componentes para los que la reparación por parte del usuario es obligatoria. Si solicita a HP que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.

[2]Optional: Opcional— componentes para los que la reparación por parte del usuario es opcional. Estos componentes también están diseñados para que puedan ser reparados por el usuario. Sin embargo, si precisa que HP realice su sustitución, puede o no conllevar costes adicionales, dependiendo del tipo de servicio de garantía correspondiente al producto.

[3]No: No—Algunos componentes no están diseñados para que puedan ser reparados por el usuario. Para que el usuario haga valer su garantía, HP pone como condición que un proveedor de servicios autorizado realice la sustitución de estos componentes. Dichos componentes se identifican con la palabra "No" en el catálogo ilustrado de componentes.

[1]Mandatory: Verplicht—Onderdelen waarvoor Customer Self Repair verplicht is. Als u HP verzoekt deze onderdelen te vervangen, komen de reiskosten en het arbeidsloon voor uw rekening.

[2]Optional: Optioneel—Onderdelen waarvoor reparatie door de klant optioneel is. Ook deze onderdelen zijn ontworpen voor reparatie door de klant. Als u echter HP verzoekt deze onderdelen voor u te vervangen, kunnen daarvoor extra kosten in rekening worden gebracht, afhankelijk van het type garantieservice voor het product.

[3]No: Nee—Sommige HP onderdelen zijn niet ontwikkeld voor reparatie door de klant. In verband met de garantievoorwaarden moet het onderdeel door een geautoriseerde Service Partner worden vervangen. Deze onderdelen worden in de geïllustreerde onderdelencatalogus aangemerkt met "Nee".

[1]Mandatory: Obrigatória—Peças cujo reparo feito pelo cliente é obrigatório. Se desejar que a HP substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

[2]Optional: Opcional—Peças cujo reparo feito pelo cliente é opcional. Essas peças também são projetadas para o reparo feito pelo cliente. No entanto, se desejar que a HP as substitua, pode haver ou não a cobrança de taxa adicional, dependendo do tipo de serviço de garantia destinado ao produto.

[3]No: Nenhuma—Algumas peças da HP não são projetadas para o reparo feito pelo cliente. A fim de cumprir a garantia do cliente, a HP exige que um técnico autorizado substitua a peça. Essas peças estão identificadas com a marca "No" (Não), no catálogo de peças ilustrado.

[1]Mandatory: 必須 - 顧客自己修理が必須の部品。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費がお客様に請求されます。

[2]Optional : 任意 - 顧客自己修理が任意である部品。この部品も顧客自己修理用です。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、お買い上げの製品に適用される保証サービス内容の範囲内においては、費用を負担していただくことなく保証サービスを受けることができます。

[3]No : 除外 - HP製品の一部の部品は、顧客自己修理用ではありません。製品の保証を継続するためには、HPまたはHP正規保守代理店による交換作業が必須となります。部品カタログには、当該部品が顧客自己修理除外品である旨が記載されています。

[1]Mandatory: 强制性的 — 要求客户必须自行维修的部件。如果您请求 HP 更换这些部件，则必须为该服务支付差旅费和人工费用。

[2]Optional: 可选的 — 客户可以选择是否自行维修的部件。这些部件也是为客户自行维修设计的。不过，如果您要求 HP 为您更换这些部件，则根据为您的产品指定的保修服务类型，HP 可能收取或不再收取任何附加费用。

[3]No: 否 — 某些 HP 部件的设计并未考虑客户自行维修。为了满足客户保修的需要，HP 要求授权服务提供商更换相关部件。这些部件在部件图解目录中标记为"否"。

[1]Mandatory: 强制的 — 客戶自行維修所使用的零件是強制性的。如果您要求 HP 更換這些零件，HP 將會向您收取此服務所需的外出費用與勞動成本。

[2]Optional: 選購的 — 客戶自行維修所使用的零件是選購的。這些零件也設計用於客戶自行維修之用。不過，如果您要求 HP 為您更換，則可能需要也可能不需要負擔額外的費用，端視針對此產品指定的保固服務類型而定。

[3]No: 否 — 某些 HP 零件沒有消費者可自行維修的設計。為符合客戶保固，HP 需要授權的服務供應商更換零件。這些零件在圖示的零件目錄中，被標示為「否」。

[1] Mandatory: 필수 — 고객 셀프 수리가 의무 사항인 필수 부품. 사용자가 HP에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.

[2] Optional: 옵션 — 고객 셀프 수리가 선택 사항인 부품. 이 부품들도 고객 셀프 수리가 가능하도록 설계되었습니다. 하지만 사용자가 HP에 이 부품의 교체를 요청할 경우 사용자가 구입한 제품에 해당하는 보증 서비스 유형에 따라 추가 비용 없이 교체가 가능할 수 있습니다.

[3] No: No — 고객 셀프 수리가 불가능하도록 설계된 HP 부품. 이 부품들은 고객 셀프 수리가 불가능하도록 설계되었습니다. HP는 고객 보증을 만족시키기 위해 공인 서비스 제공업체를 통해 부품을 교체하도록 하고 있습니다.

Removal and replacement procedures

Required tools

You need the following items for some procedures:

- T-10/T-15 Torx screwdriver (included with the server)
- HP Insight Diagnostics software ("HP Insight Diagnostics" on page 67)

Safety considerations

Before performing service procedures, review all the safety information.

Preventing electrostatic discharge

To prevent damaging the system, be aware of the precautions you need to follow when setting up the system or handling parts. A discharge of static electricity from a finger or other conductor may damage system boards or other static-sensitive devices. This type of damage may reduce the life expectancy of the device.

To prevent electrostatic damage:

- Avoid hand contact by transporting and storing products in static-safe containers.
- Keep electrostatic-sensitive parts in their containers until they arrive at static-free workstations.
- Place parts on a grounded surface before removing them from their containers.
- Avoid touching pins, leads, or circuitry.
- Always be properly grounded when touching a static-sensitive component or assembly.

Symbols on equipment

The following symbols may be placed on equipment to indicate the presence of potentially hazardous conditions.

⚠️ ⚡	This symbol indicates the presence of hazardous energy circuits or electric shock hazards. Refer all servicing to qualified personnel. **WARNING:** To reduce the risk of injury from electric shock hazards, do not open this enclosure. Refer all maintenance, upgrades, and servicing to qualified personnel.
⚠️ ⊘	This symbol indicates the presence of electric shock hazards. The area contains no user or field serviceable parts. Do not open for any reason. **WARNING:** To reduce the risk of injury from electric shock hazards, do not open this enclosure.

This symbol on an RJ-45 receptacle indicates a network interface connection.
WARNING: To reduce the risk of electric shock, fire, or damage to the equipment, do not plug telephone or telecommunications connectors into this receptacle.
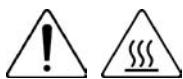
This symbol indicates the presence of a hot surface or hot component. If this surface is contacted, the potential for injury exists.
WARNING: To reduce the risk of injury from a hot component, allow the surface to cool before touching.
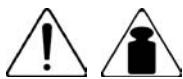
49 - 109 kg
100 - 240 lb

This symbol indicates that the component exceeds the recommended weight for one individual to handle safely.
WARNING: To reduce the risk of personal injury or damage to the equipment, observe local occupational health and safety requirements and guidelines for manual material handling.

These symbols, on power supplies or systems, indicate that the equipment is supplied by multiple sources of power.
WARNING: To reduce the risk of injury from electric shock, remove all power cords to completely disconnect power from the system.

Rack warnings

WARNING: To reduce the risk of personal injury or damage to the equipment, be sure that:
- The leveling jacks are extended to the floor.
- The full weight of the rack rests on the leveling jacks.
- The stabilizing feet are attached to the rack if it is a single-rack installation.
- The racks are coupled together in multiple-rack installations.
- Only one component is extended at a time. A rack may become unstable if more than one component is extended for any reason.

WARNING: To reduce the risk of personal injury or equipment damage when unloading a rack:
- At least two people are needed to safely unload the rack from the pallet. An empty 42U rack can weigh as much as 115 kg (253 lb), can stand more than 2.1 m (7 ft) tall, and may become unstable when being moved on its casters.
- Never stand in front of the rack when it is rolling down the ramp from the pallet. Always handle the rack from both sides.

WARNING: To reduce the risk of personal injury or damage to the equipment, adequately stabilize the rack before extending a component outside the rack. Extend only one component at a time. A rack may become unstable if more than one component is extended.

WARNING: When installing a server in a telco rack, be sure that the rack frame is adequately secured at the top and bottom to the building structure.

Server warnings and cautions

Before installing a server, be sure that you understand the following warnings and cautions.

⚠ **WARNING:** To reduce the risk of electric shock or damage to the equipment:
- Do not disable the power cord grounding plug. The grounding plug is an important safety feature.
- Plug the power cord into a grounded (earthed) electrical outlet that is easily accessible at all times.
- Unplug the power cord from the power supply to disconnect power to the equipment.
- Do not route the power cord where it can be walked on or pinched by items placed against it. Pay particular attention to the plug, electrical outlet, and the point where the cord extends from the server.

⚠ **WARNING:** To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

⚠ **CAUTION:** Do not operate the server for long periods with the access panel open or removed. Operating the server in this manner results in improper airflow and improper cooling that can lead to thermal damage.

Preparation procedures

To access some components and perform certain service procedures, you must perform one or more of the following procedures:

- Power down the server (on page).

  If you must remove a server from a rack, power down the server.

- Remove the server from the rack (on page).

  To access internal server components, remove the server from the rack.

Power down the server

⚠ **WARNING:** To reduce the risk of personal injury, electric shock, or damage to the equipment, remove the power cord to remove power from the server. The front panel Power On/Standby button does not completely shut off system power. Portions of the power supply and some internal circuitry remain active until AC power is removed.

📝 **IMPORTANT:** If installing a hot-plug device, it is not necessary to power down the server.

1. Back up the server data.
2. Shut down the operating system as directed by the operating system documentation.

   NOTE: If the operating system automatically places the server in Standby mode, omit the next step.

3. Press the Power On/Standby button to place the server in Standby mode. When the server activates Standby power mode, the system power LED changes to amber.

   📝 **IMPORTANT:** Pressing the UID button illuminates the blue UID LEDs on the front and rear panels. In a rack environment, this feature facilitates locating a server when moving between the front and rear of the rack.

4. Disconnect the power cords.

The system is now without power.

Remove the server from the rack

⚠ **WARNING:** The server is not attached to the rack mounting rails. To avoid potential damage to the server and personal injury, always support the server with both hands when removing it from the rack.

To remove the server from an HP, Compaq branded, telco, or third-party rack:

1. Power down the server (on page 25).
2. Disconnect all peripheral cables and power cords from the server rear panel.
3. Loosen the thumbscrews that secure the server faceplate to the front of the rack.
4. Remove the server from the rack. For more information, see the documentation that ships with the rack mounting option.
5. Place the server on a sturdy, level surface.

Hard drive blank

⚠ **CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

Remove the component as indicated.
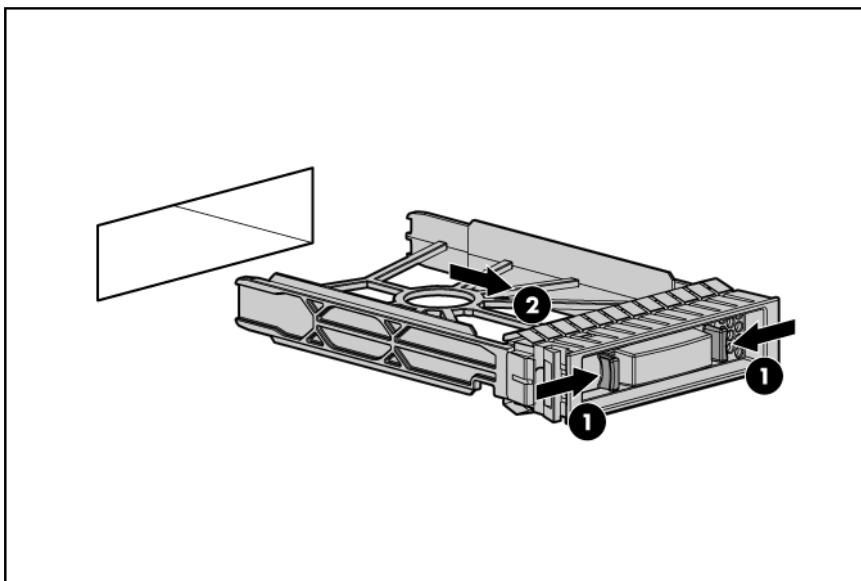
To replace the component, reverse the removal procedure.

Hard drive

📝 **IMPORTANT:** Hot-plug capability and drive LED support are only available when a supported optional controller is installed in the server.

To remove the component:

1. Back up all data on the hard drive.
2. Power down the server (on page).

   ⚠ **CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

3. Remove the hard drive.
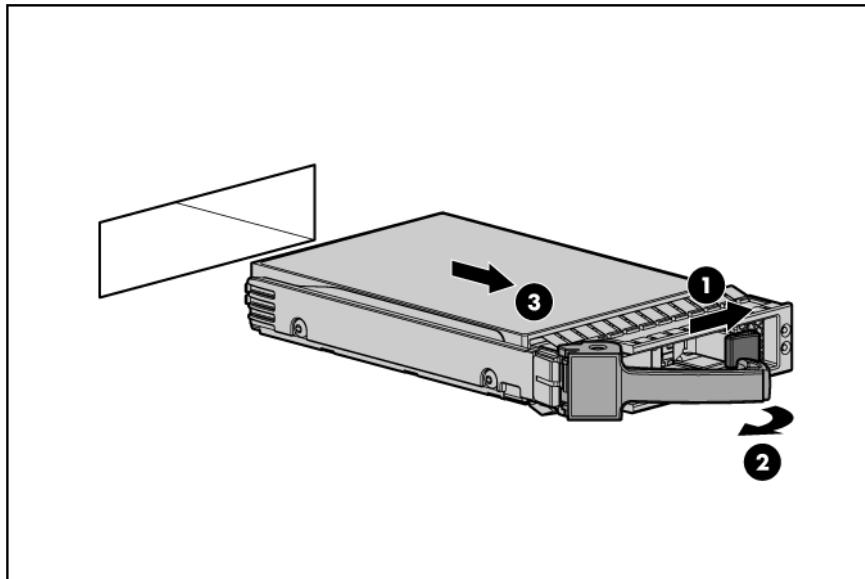
To replace the component, reverse the removal procedure.

When adding hard drives to the server, observe the following general guidelines:

- The system automatically sets all drive numbers.
- If only one hard drive is used, install it in the bay with the lowest drive number.
- Drives must be the same capacity to provide the greatest storage space efficiency when drives are grouped together into the same drive array.

Optional storage controllers provide support for hot-plug capability and drive LEDs. Controller options are as follows:

- The embedded controller supports SATA hard drives and drive LEDs in hot-plug carriers. Hot-plug operation is not supported.
- Optional SAS controllers support hot-plug SAS or SATA hard drives and drive LEDs.

   NOTE: ACU does not support mixing SAS and SATA drives in the same logical volume.

Access panel

⚠ **WARNING:** To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

> **⚠ CAUTION:** Do not operate the server for long periods with the access panel open or removed. Operating the server in this manner results in improper airflow and improper cooling that can lead to thermal damage.

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Open the latch, slide the access panel to the rear of the chassis, and remove the access panel.

    If the latch is locked, use a T-15 Torx screwdriver to unlock the latch.

To replace the component, reverse the removal procedure.

Air baffle

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Remove the air baffle.
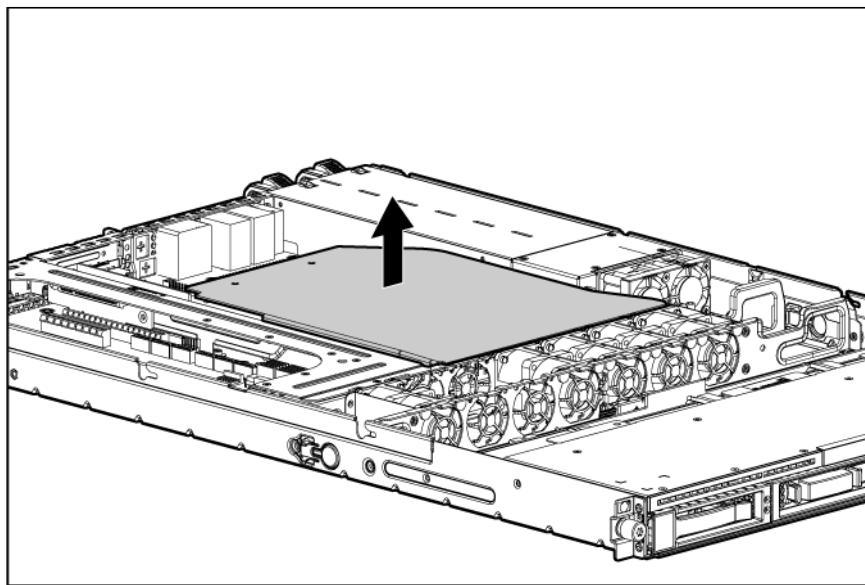
To replace the component, reverse the removal procedure.

Redundant hot-plug power supply

> **⚠ WARNING:** To reduce the risk of personal injury from hot surfaces, allow the power supply or power supply blank to cool before touching it.

> **⚠ CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To remove the component:

1. Determine how many hot-plug power supplies are installed:

   o If only one hot-plug power supply is installed, power down the server (on page).

   o If more than one hot-plug power supply is installed, continue with the next step.

2. Disconnect the power cord from the source.

3. Remove the power cord from the power supply.

4. Remove the power supply from the server.
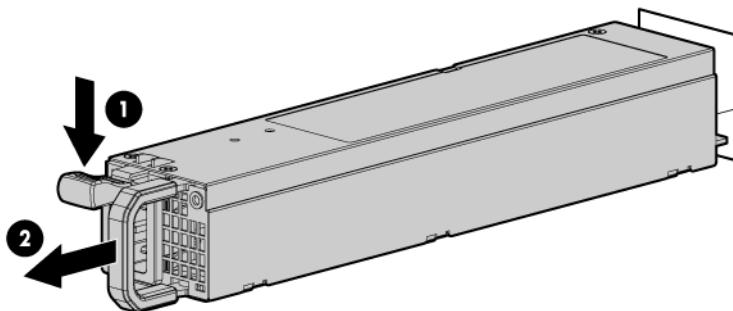
⚠ **WARNING:** To reduce the risk of electric shock or damage to the equipment, do not connect the power cord to the power supply until the power supply is installed.

To replace the component:

1. Install the power supply.
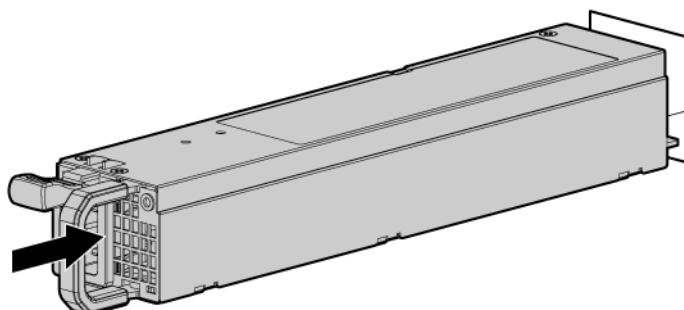
2. Connect the power cord to the power supply.

3. Connect the power cord to the power source.

Redundant hot-plug power supply cage

WARNING: To reduce the risk of personal injury from hot surfaces, allow the power supply or power supply blank to cool before touching it.

CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To remove the component:

1. Power down the server (on page 25).
2. Remove the redundant hot-plug power supplies ("Redundant hot-plug power supply" on page 28).
3. Remove the server from the rack (on page 26).
4. Remove the access panel ("Access panel" on page 27).
5. Remove the air baffle ("Air baffle" on page 28).
6. Disconnect the power supply cables.

   For more information, see "Optional redundant power supply cabling (on page 81)."
7. Remove the power supply cage.
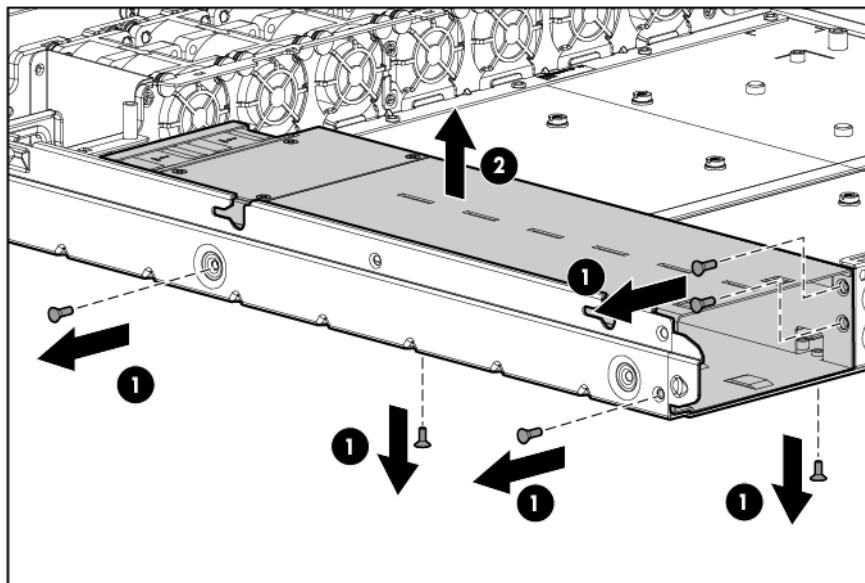
To replace the component:

1. Install the power supply cage.
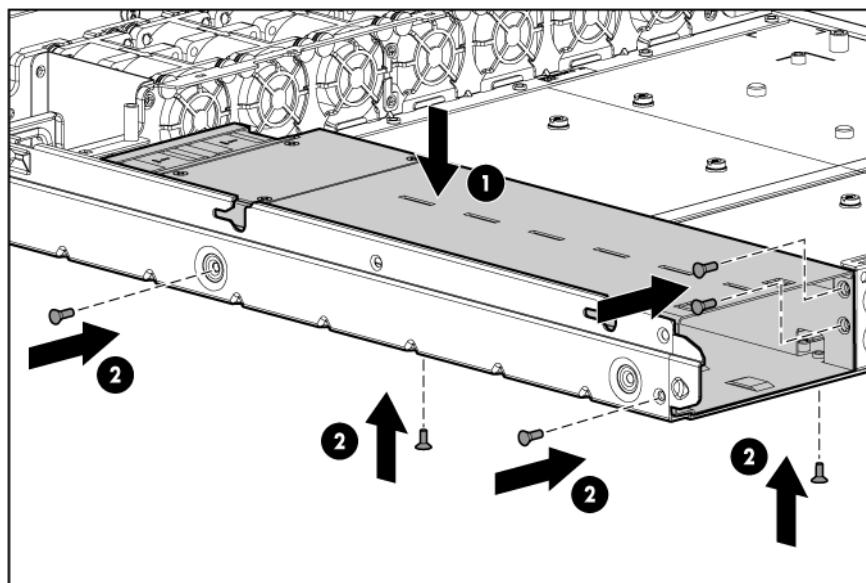
2. Connect the power supply cables.
3. Install the air baffle ("Air baffle" on page 28).
4. Install the access panel ("Access panel" on page 27).
5. Install the server into the rack.
6. Install the redundant hot-plug power supplies ("Redundant hot-plug power supply" on page 28).
7. Power up the server.

460-W pluggable AC power supply

⚠ **WARNING:** To reduce the risk of personal injury from hot surfaces, allow the power supply or power supply blank to cool before touching it.

⚠ **CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To remove the component:

1. Power down the server (on page 25).
2. Disconnect the power cord from the source.
3. Remove the power cord from the power supply.

4. Remove the power supply from the server.

WARNING: To reduce the risk of electric shock or damage to the equipment, do not connect the power cord to the power supply until the power supply is installed.

To replace the component:

1. Install the power supply.

2. Connect the power cord to the power supply.
3. Connect the power cord to the power source.
4. Power up the server.

460-W pluggable AC power supply backplane

WARNING: To reduce the risk of personal injury from hot surfaces, allow the power supply or power supply blank to cool before touching it.

CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To remove the component:

1. Power down the server (on page 25).

2. Remove the 460-W pluggable AC power supply ("460-W pluggable AC power supply" on page 31).

3. Remove the server from the rack (on page 26).

4. Remove the access panel ("Access panel" on page 27).

5. Remove the air baffle ("Air baffle" on page 28).

6. Remove the power supply cage.
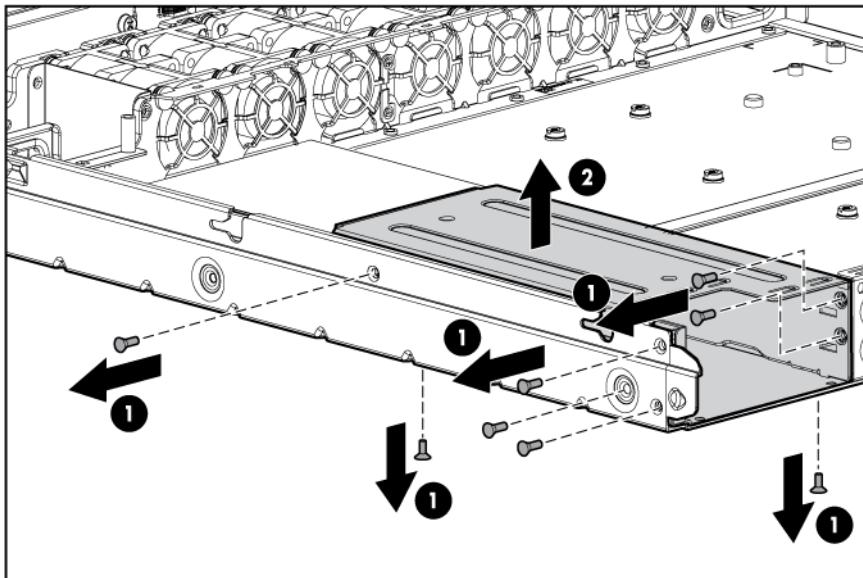
7. Remove the power supply backplane.
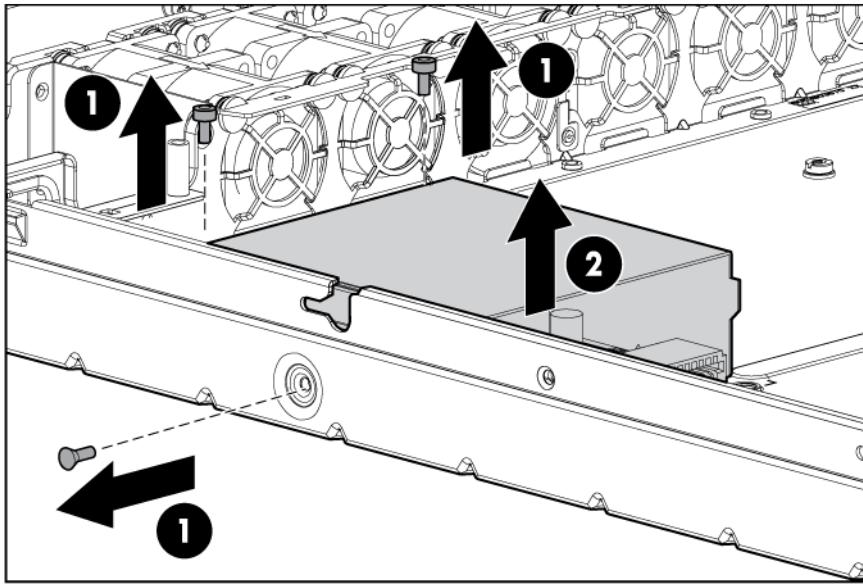
To replace the component, reverse the removal procedure.

Non-hot-plug power supply bracket

⚠ **WARNING:** To reduce the risk of personal injury from hot surfaces, allow the power supply or power supply blank to cool before touching it.

⚠ **CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Remove the air baffle ("Air baffle" on page 28).
5. Remove the power supply bracket.
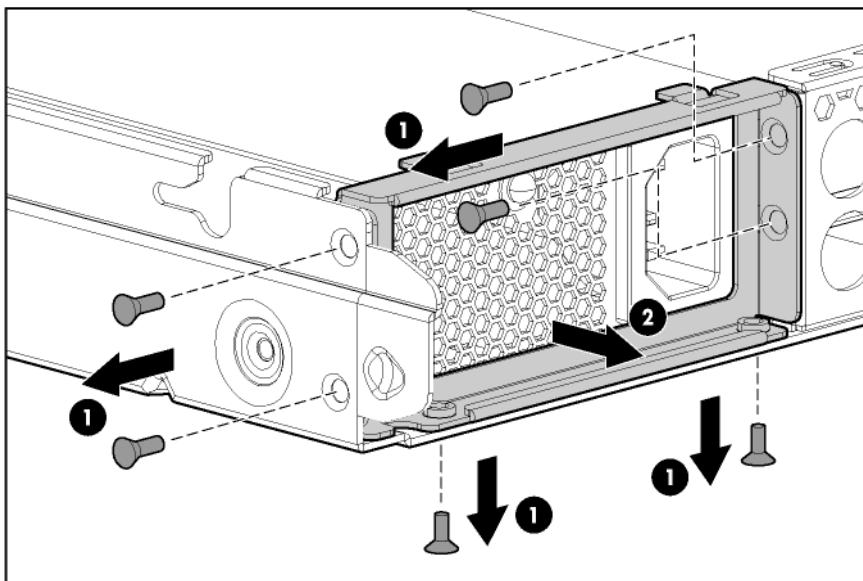
To replace the component, reverse the removal procedure.

Non-hot-plug power supply

⚠ **WARNING:** To reduce the risk of personal injury from hot surfaces, allow the power supply or power supply blank to cool before touching it.

⚠ **CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To remove the component:

1. Power down the server (on page 25).
2. Disconnect the power cord from the source.
3. Disconnect the power cord from the power supply.
4. Remove the server from the rack (on page 26).
5. Remove the access panel ("Access panel" on page 27).
6. Remove the air baffle ("Air baffle" on page 28).

7. Disconnect the power supply cables.

    For more information, see "Non-redundant power supply cabling (on page 80)."

8. Remove the power supply bracket.
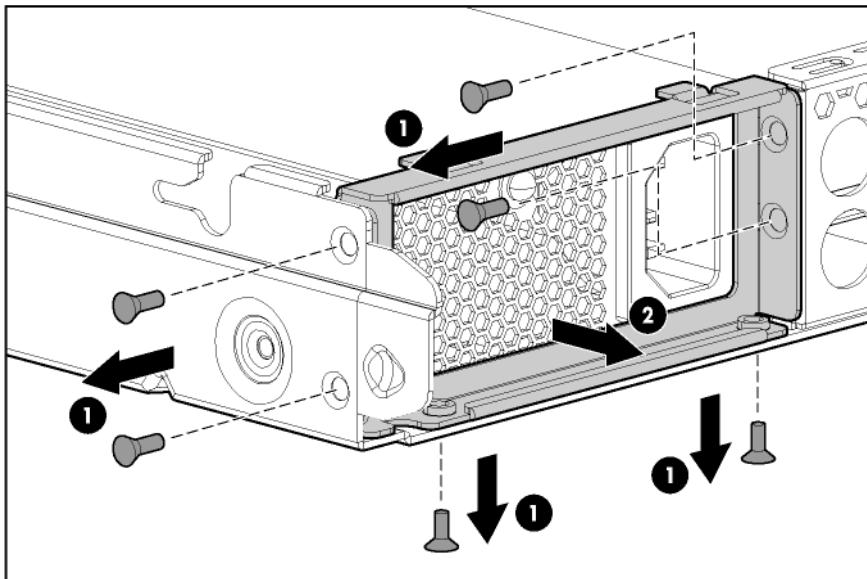
9. Remove the power supply.
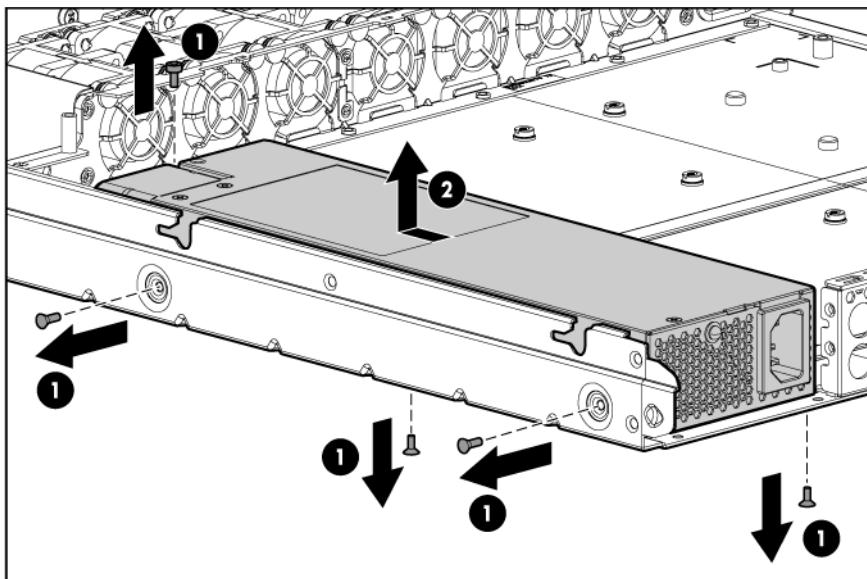
⚠ **WARNING:** To reduce the risk of electric shock or damage to the equipment, do not connect the power cord to the power supply until the power supply is installed.

To replace the component:

1. Install the power supply.
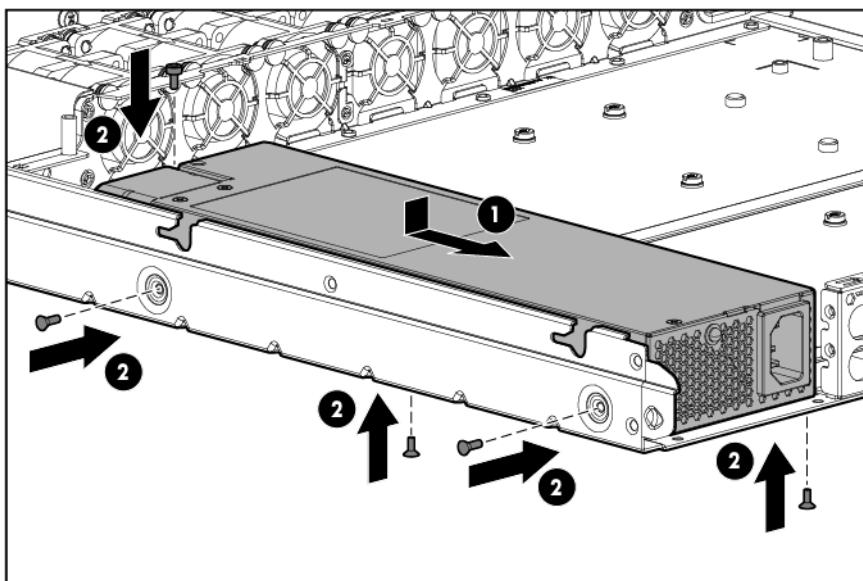
2. Install the power supply bracket.
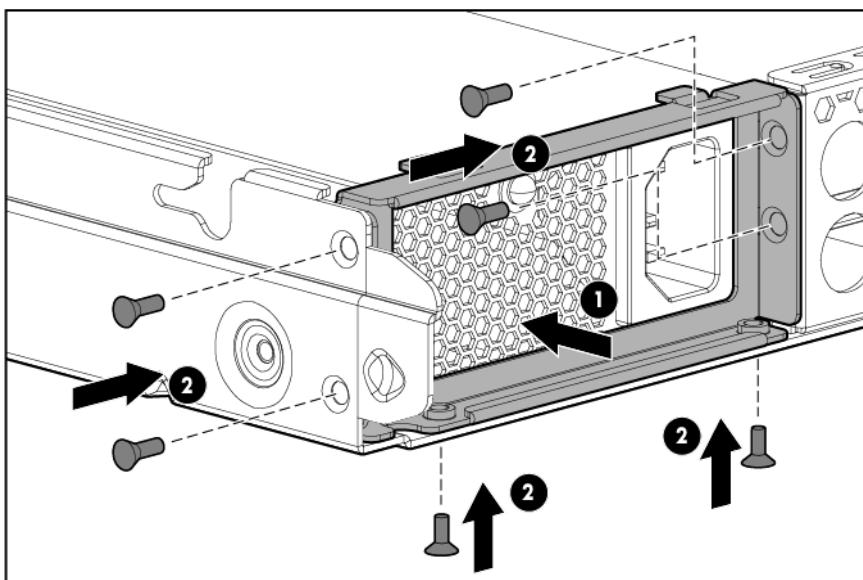
3. Connect the power supply cables.
4. Install the air baffle ("Air baffle" on page 28).
5. Install the access panel ("Access panel" on page 27).
6. Install the server into the rack.
7. Connect the power cord to the power supply.
8. Connect the power cord to the power source.
9. Power up the server.

Fan

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Remove the air baffle ("Air baffle" on page 28).
5. Remove the fan.
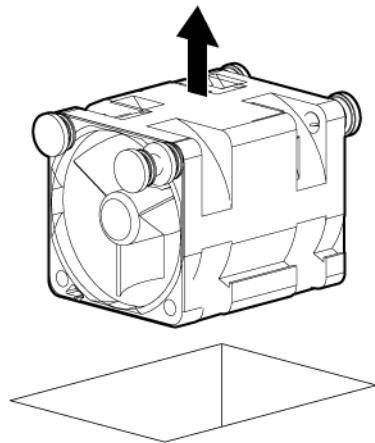
To replace the component, reverse the removal procedure.

Fan clip

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Remove the air baffle ("Air baffle" on page 28).
5. Remove all fans ("Fan" on page 37).

6. Remove the fan clip.
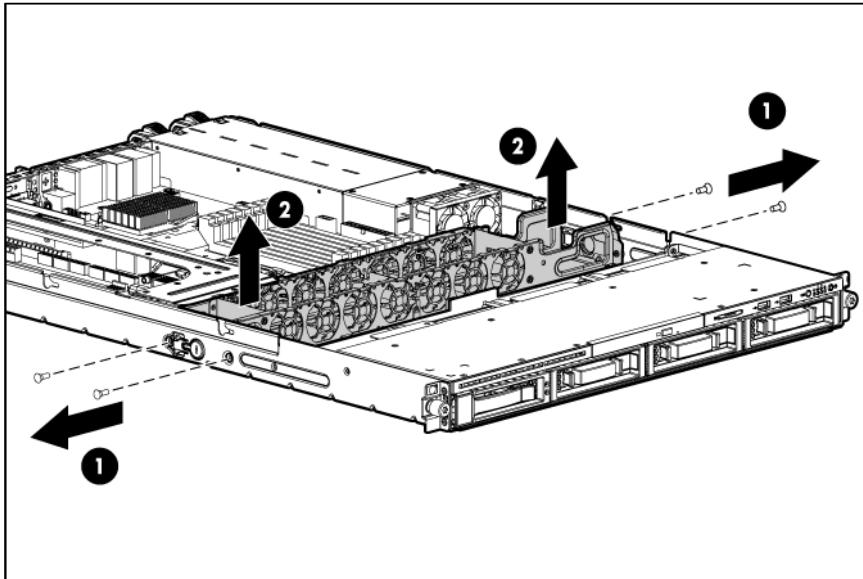
To replace the component, reverse the removal procedure.

Optical drive

⚠ **CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Disconnect the cables from the optical drive.
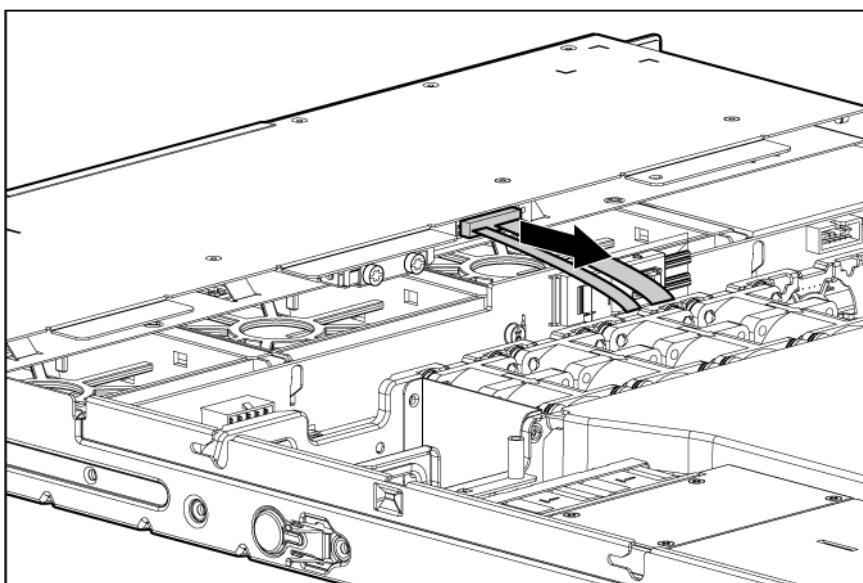
5. Remove the optical drive screws.
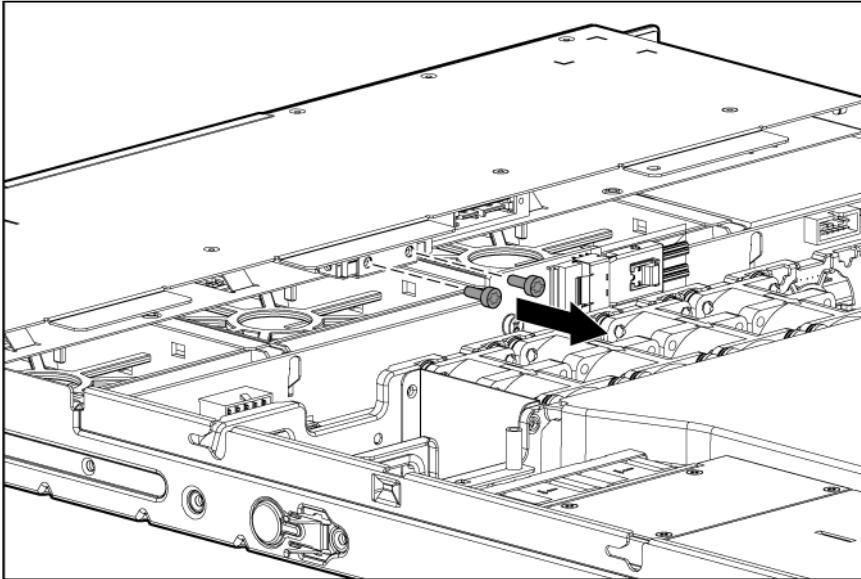

6. Remove the optical drive assembly.
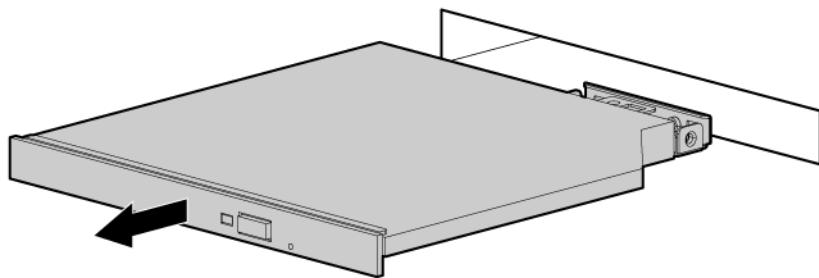
To replace the component, reverse the removal procedure.

Hard drive cage

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Remove all hard drive blanks ("Hard drive blank" on page 26).
5. Remove all hard drives ("Hard drive" on page 26).
6. Remove the optical drive ("Optical drive" on page 38), if installed.
7. Disconnect the front I/O cable.

The air baffle is not shown for clarity.
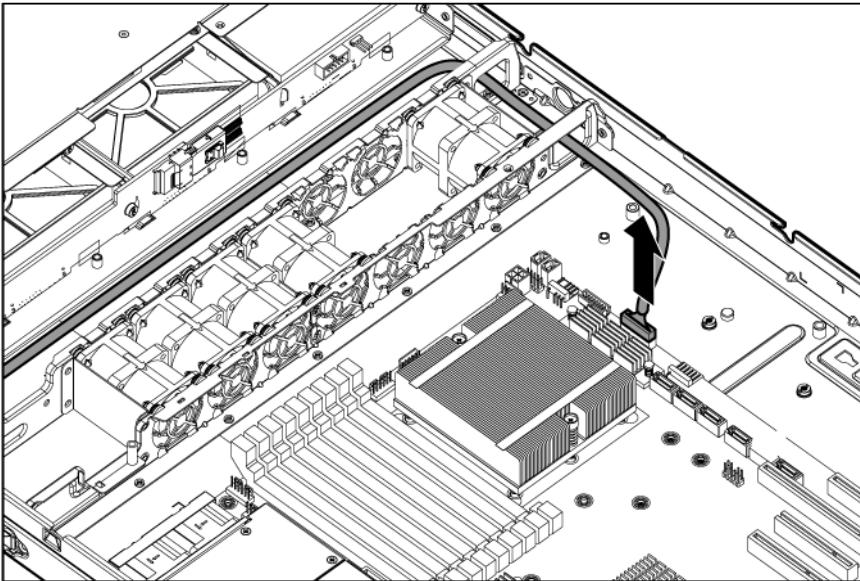
8. Remove the front I/O assembly.
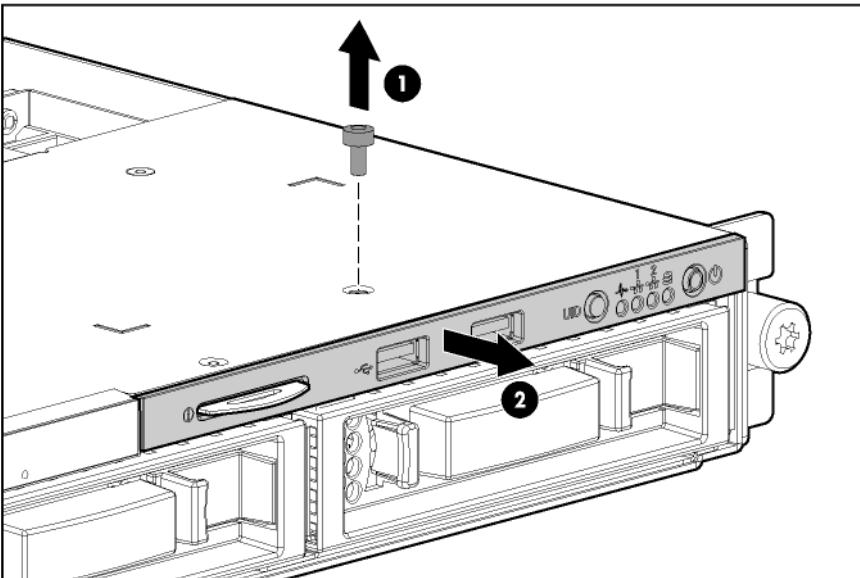
9. Disconnect the hard drive cables from the system board.

10. Remove the hard drive cage.
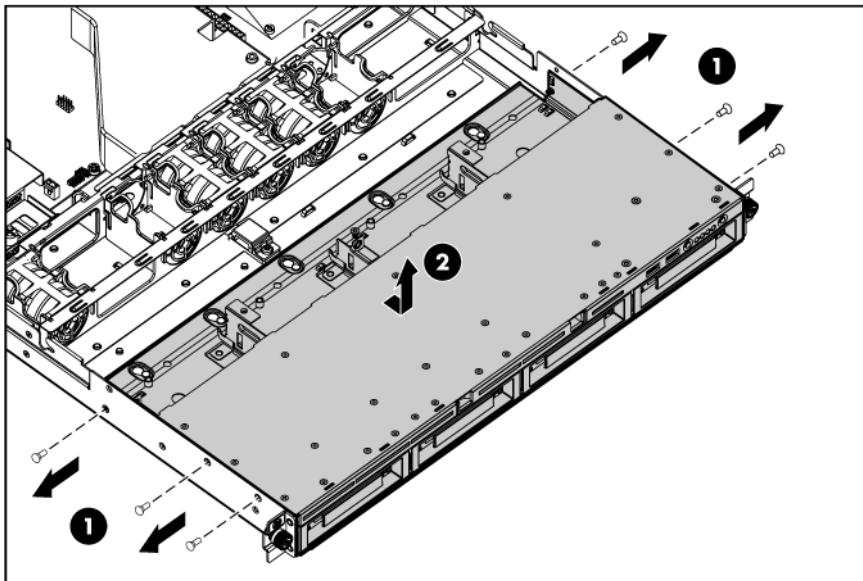
To replace the component, reverse the removal procedure.

SAS/SATA backplane

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Remove the air baffle ("Air baffle" on page 28).
5. Remove all hard drives ("Hard drive" on page 26).
6. Disconnect the hard drive cables from the system board.
7. Remove the backplane.
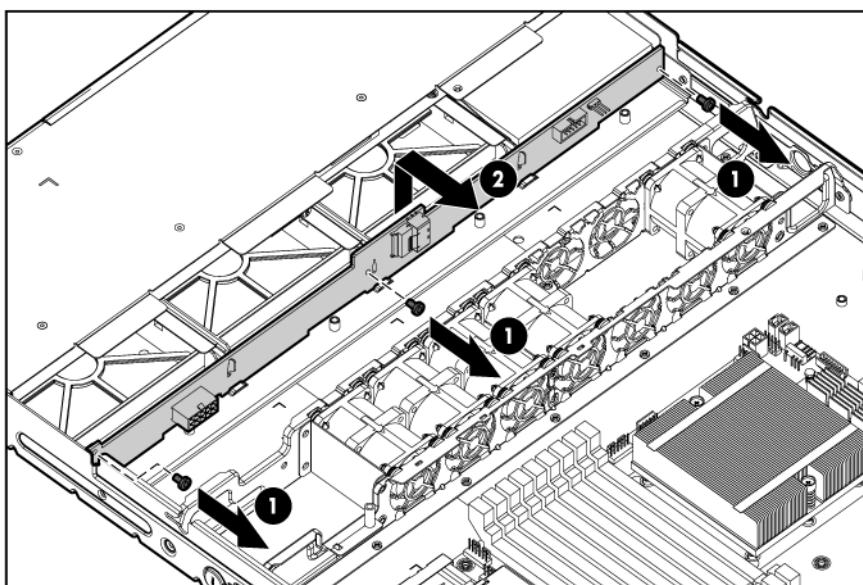
To replace the component, reverse the removal procedure.

PCI riser board assembly

⚠ **CAUTION:** To prevent damage to the server or expansion boards, power down the server and remove all AC power cords before removing or installing the PCI riser board assembly.

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Remove the air baffle ("Air baffle" on page 28).
5. Disconnect internal or external cables connected to expansion boards.
6. Remove the PCI riser board assembly.
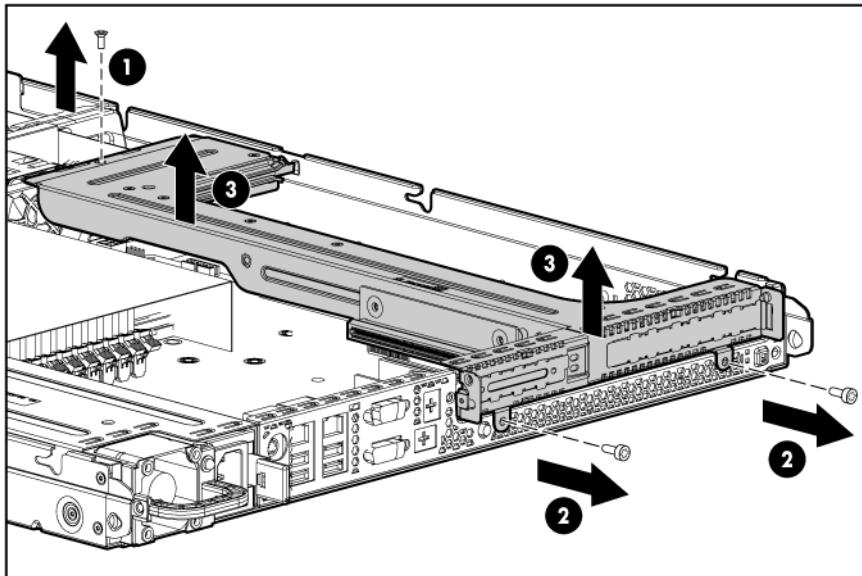
To replace the component, reverse the removal procedure.

Expansion board

To remove the component:

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Remove the air baffle ("Air baffle" on page 28).
5. Remove the PCI riser board assembly ("PCI riser board assembly" on page 42).

6. Remove the expansion board.
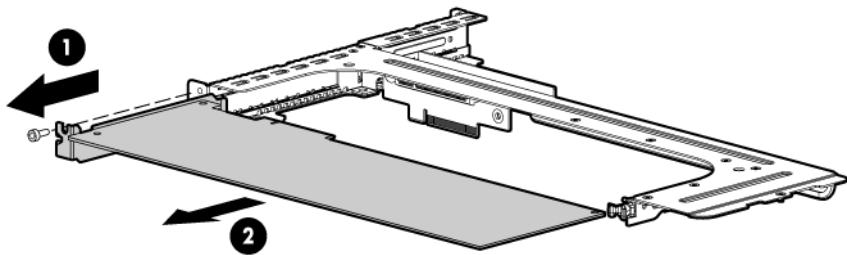
To replace the component, reverse the removal procedure.

Battery-backed write cache procedures

Two types of procedures are provided for the BBWC option:

- Removal and replacement of failed components:
  - o Removing the cache module ("Cache module" on page 43)
  - o Removing the battery pack ("Cache battery" on page 44)
- Recovery of cached data from a failed server ("Recovering data from the battery-backed write cache" on page 45)

⚠ **CAUTION:** Do not detach the cable that connects the battery pack to the cache module. Detaching the cable causes any unsaved data in the cache module to be lost.

Cache module

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Remove the air baffle ("Air baffle" on page 28).
5. Remove the PCI riser board assembly ("PCI riser board assembly" on page 42).
6. Remove the expansion board ("Expansion board" on page 42).

7. Disconnect the battery pack from the controller.
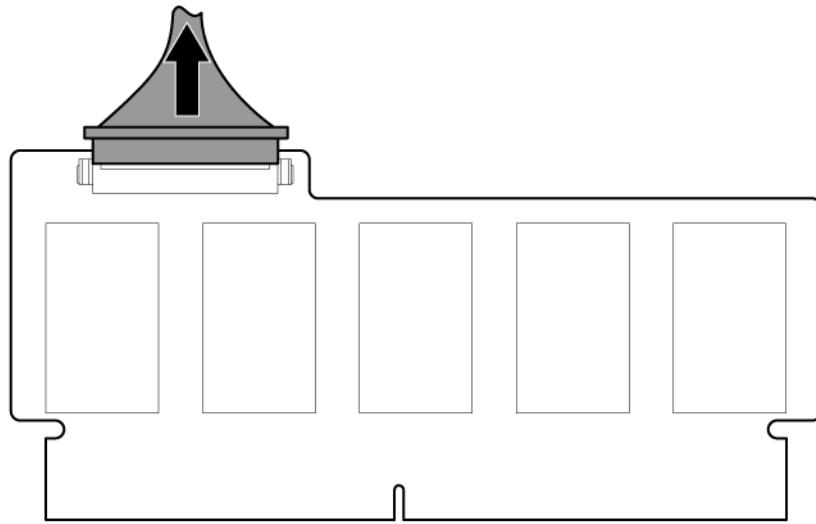
8. Remove the cache module.
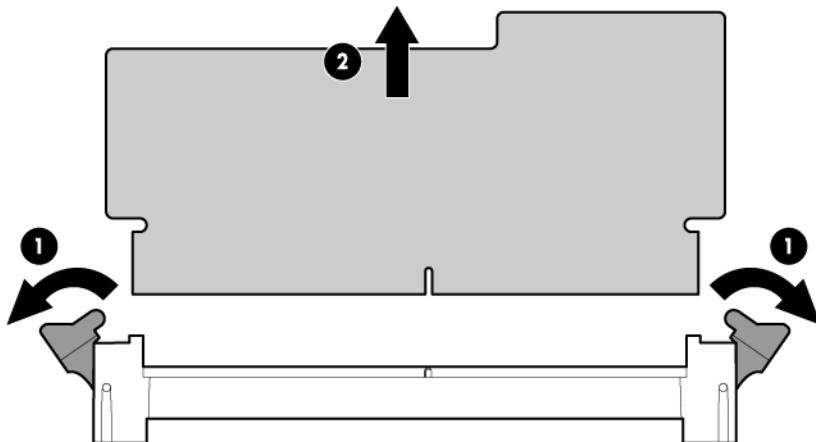
To replace the component, reverse the removal procedure.

Cache battery

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Remove the air baffle ("Air baffle" on page 28).

5. Remove the cache battery.
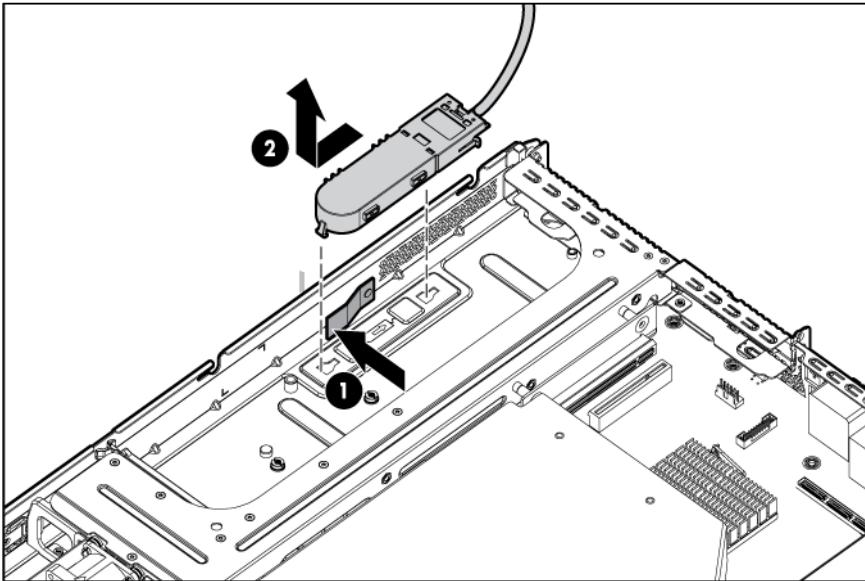
6. Disconnect the battery pack.
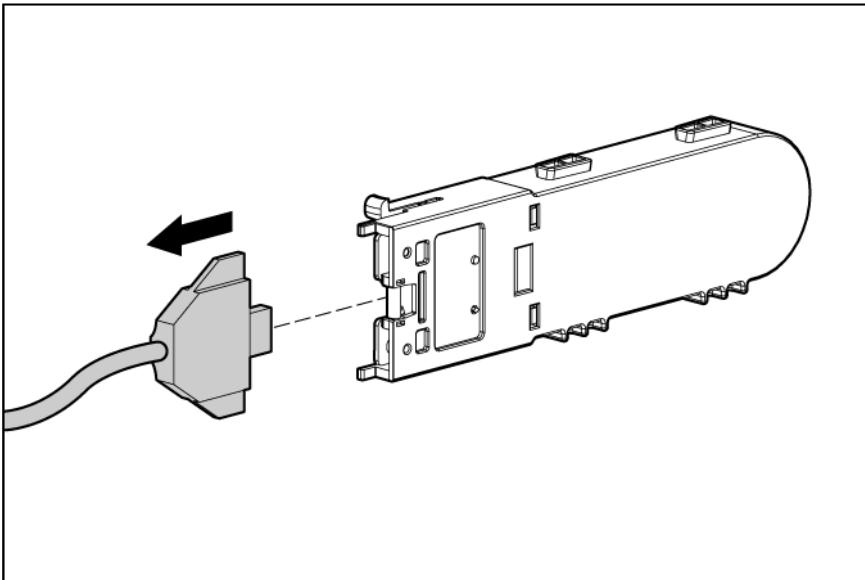
To replace the component, reverse the removal procedure.

Recovering data from the battery-backed write cache

If the server fails, use the following procedure to recover data temporarily stored in the BBWC.

△ **CAUTION:** Before starting this procedure, read the information about protecting against electrostatic discharge ("Preventing electrostatic discharge" on page 23).

1. Perform one of the following:

   o Set up a recovery server station using an identical server model. Do not install any internal drives or BBWC in this server. (HP recommends this option.)

- o Find a server that has enough empty drive bays to accommodate all the drives from the failed server and that meets all the other requirements for drive and array migration.

2. Power down the failed server ("Power down the server" on page 25). If any data is stored in the cache module, a green LED on the module flashes every 2 seconds.

   ⚠ **CAUTION:** Do not detach the cable that connects the battery pack to the cache module. Detaching the cable causes any unsaved data in the cache module to be lost.

3. Transfer the hard drives from the failed server to the recovery server station.

4. Perform one of the following:
   - o If the array controller has failed, remove the cache module (on page 43) and battery pack ("Cache battery" on page 44) from the failed array controller, and install the cache module and battery pack on an array controller in the recovery server.
   - o If the server has failed, remove the controller, cache module (on page 43), and battery pack ("Cache battery" on page 44) from the failed server, and install the controller, cache module, and battery pack in the recovery server.

5. Power up the recovery server. A 1759 POST message is displayed, stating that valid data was flushed from the cache. This data is now stored on the drives in the recovery server. You can now transfer the drives (and controller, if one was used) to another server.

Flash-backed write cache procedures

Two types of procedures are provided for the FBWC option:

- Removal and replacement of failed components:
  - o Removing the cache module ("Flash-backed write cache module" on page 46)
  - o Removing the capacitor pack ("Flash-backed write cache capacitor pack" on page 48)
- Recovery of cached data from a failed server ("Recovering data from the battery-backed write cache" on page 45)

   ⚠ **CAUTION:** Do not detach the cable that connects the battery pack or capacitor pack to the cache module. Detaching the cable causes any unsaved data in the cache module to be lost.

Flash-backed write cache module

To remove the component:

   ⚠ **CAUTION:** Do not use this controller with cache modules designed for other controller models, because the controller can malfunction and you can lose data. Also, do not transfer this cache module to a different controller module, because you can lose data.

1. Back up all data.
2. Close all applications.
3. Power down the server (on page 25).

   ⚠ **CAUTION:** In systems that use external data storage, be sure that the server is the first unit to be powered down and the last to be powered back up. Taking this precaution ensures that the system does not erroneously mark the drives as failed when the server is powered up.

4. Extend the server from the rack.

5. Remove the access panel ("Access panel" on page 27).

6. Remove the PCI riser board assembly ("PCI riser board assembly" on page 42).

7. If the existing cache module is connected to a capacitor pack, observe the FBWC module LEDs (on page 79):

   o If the amber LED is flashing, data is trapped in the cache. Restore system power, and restart this procedure from step 1.

   o If the amber LED is not illuminated, remove the controller from the server, and then continue with the next step.

8. Open the ejector latches on each side of the cache module connector. Normally, the cache module is ejected from the cache module connector. If the module is not ejected automatically, remove the cache module.
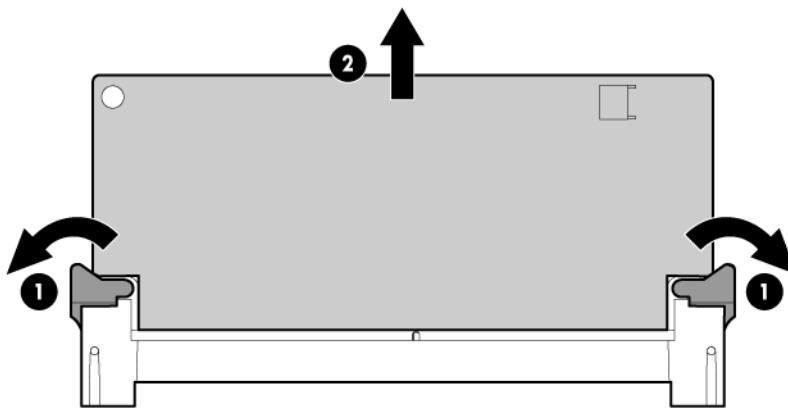
9. If the cache module is connected to a capacitor pack, disconnect the capacitor pack cable from the connector on the top of the cache module.
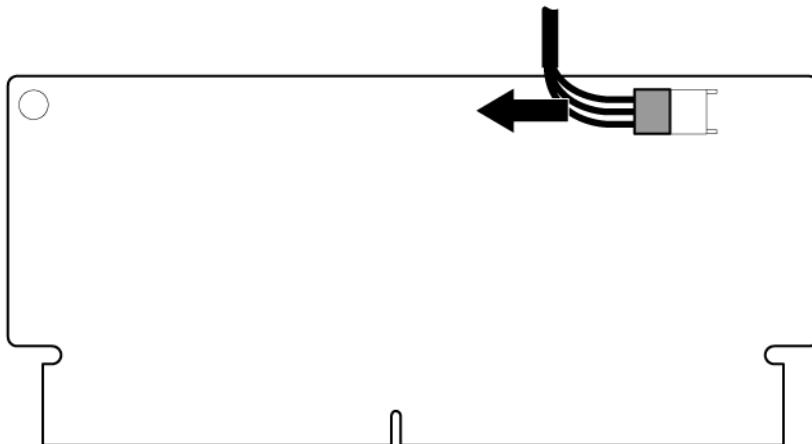
To replace the component, reverse the removal procedure.

⚠ **CAUTION:** To prevent damage to the cache module during installation, be sure the cache module is fully inserted before pressing down.

Flash-backed write cache capacitor pack

To remove the component:

1. Back up all data.

2. Close all applications.

3. Power down the server (on page 25).

   ⚠ **CAUTION:** In systems that use external data storage, be sure that the server is the first unit to be powered down and the last to be powered back up. Taking this precaution ensures that the system does not erroneously mark the drives as failed when the server is powered up.

4. Extend the server from the rack.

5. Remove the access panel ("Access panel" on page 27).

6. Remove the PCI riser board assembly ("PCI riser board assembly" on page 42).

7. If the capacitor pack is connected to the cache module, disconnect the capacitor pack cable from the connector on the top of the cache module.
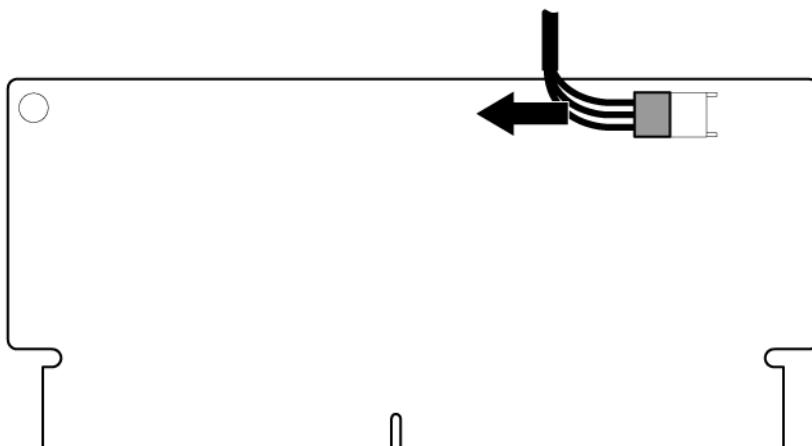
8. Disconnect the capacitor pack from the air baffle.
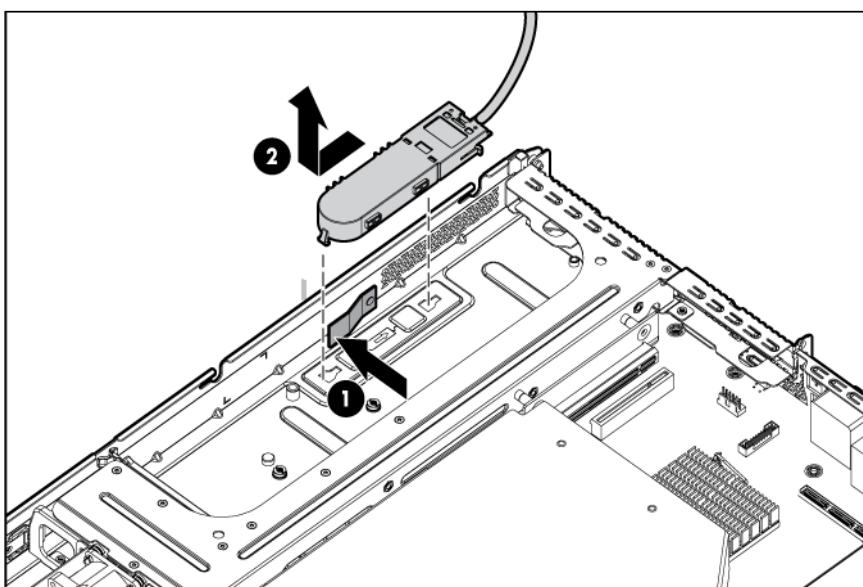
To replace the component, reverse the removal procedure.

Dedicated iLO 2 connector module

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Remove the module.
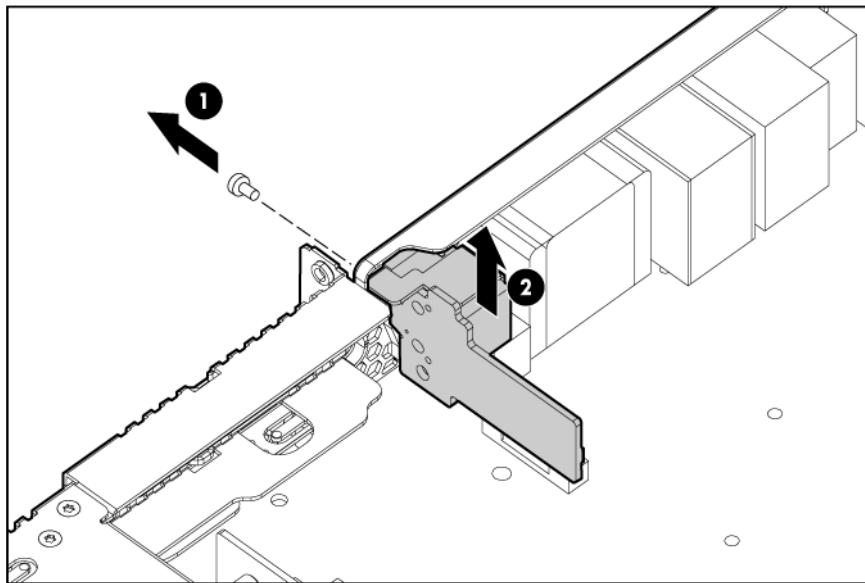
To replace the component, reverse the removal procedure.

DIMMs

IMPORTANT: This server does not support mixing RDIMMs and UDIMMs. Attempting to mix these two types causes the server to halt during BIOS initialization.

To identify the DIMMs installed in the server, see "DIMM identification (on page 76)."

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Remove the air baffle ("Air baffle" on page 28).
5. Open the DIMM slot latches.

6. Remove the DIMM.
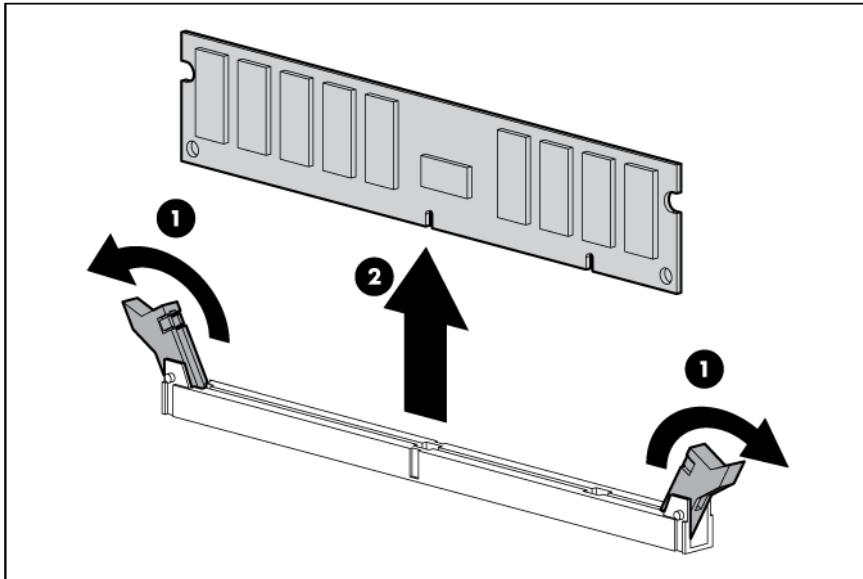
To replace the component, reverse the removal procedure.

For DIMM configuration information, see the server user guide.

Heatsink

⚠ **WARNING:** To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Remove the air baffle ("Air baffle" on page 28).

⚠ **CAUTION:** Heatsink retaining screws should be loosened in diagonally opposite pairs (in an "X" pattern).

5. Loosen the four screws securing the heatsink:
   a. Loosen each screw three or four turns in the counterclockwise direction.
   b. Fully loosen the screws to free the heatsink, being careful not to remove the screw assemblies from the heatsink.

6. Remove the heatsink.
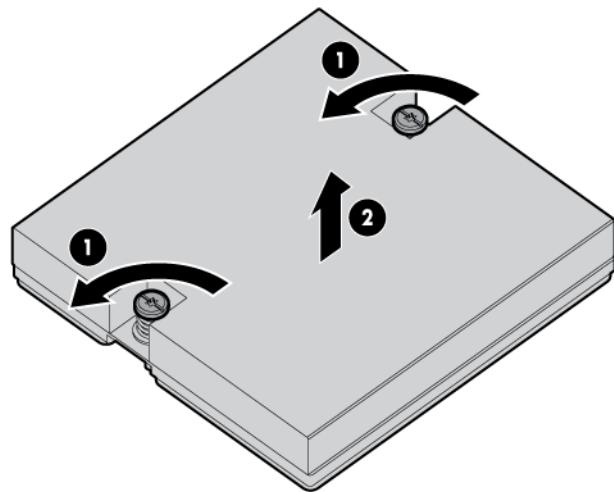
To replace the component:

📝 **IMPORTANT:** When replacing the heatsink, check the label on top to be sure the heatsink is properly oriented.

1. Use the alcohol swab to remove all the existing thermal grease from the processor. Allow the alcohol to evaporate before continuing.
2. Remove the protective cover from the heatsink.
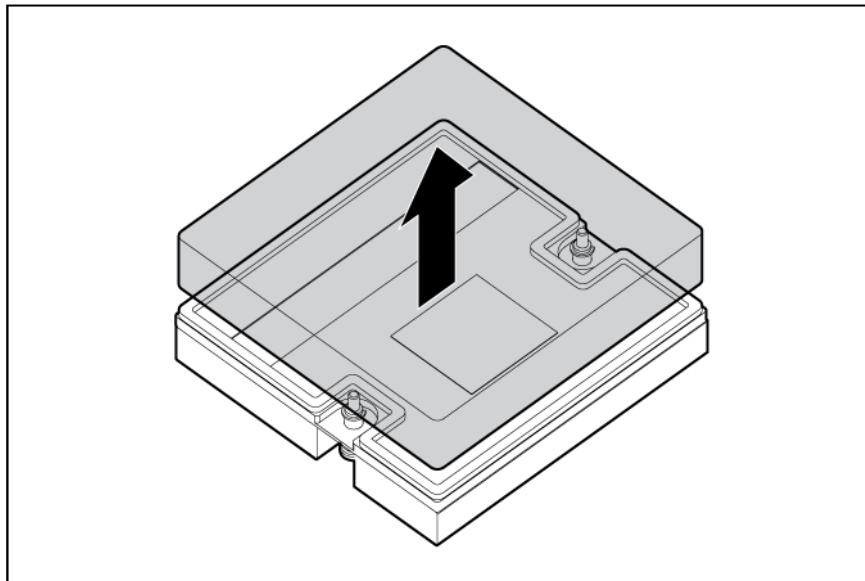
3. Install the heatsink.
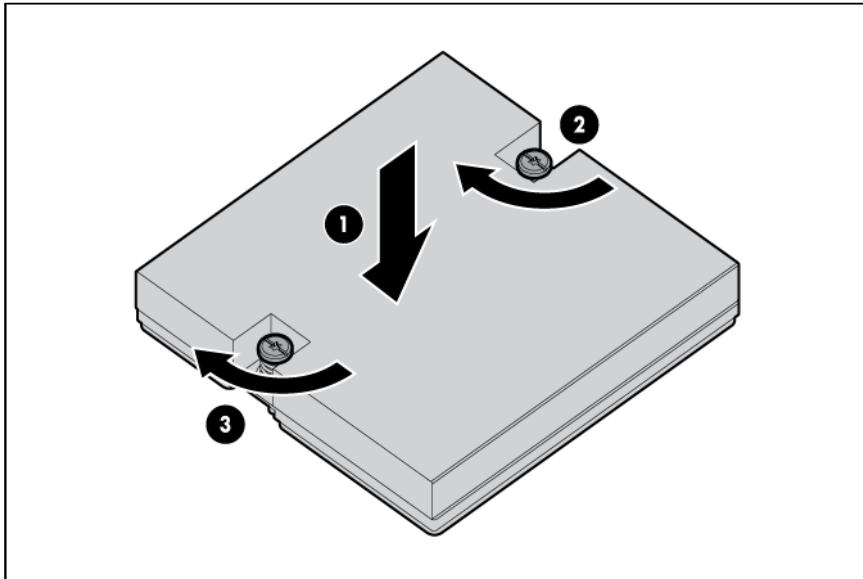
4. Install the air baffle ("Air baffle" on page 28).
5. Install the access panel ("Access panel" on page 27).

Processor

⚠ **WARNING:** To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

To remove the component:

1. Power down the server (on page 25).
2. Remove the server from the rack (on page 26).
3. Remove the access panel ("Access panel" on page 27).
4. Remove the air baffle ("Air baffle" on page 28).
5. Remove the heatsink ("Heatsink" on page 50).

6. Open the processor locking lever and the processor socket retaining bracket.
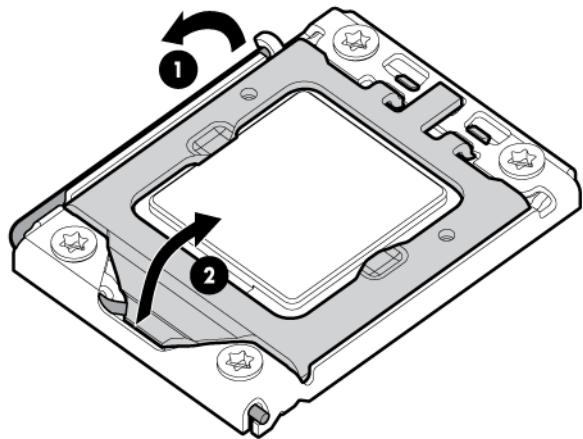
7. Using the processor tool, remove the processor from the system board:
   a. Line up the processor tool, ensuring the locking lever graphic on the tool is oriented correctly.
   b. Press in on the plastic tabs, and then place the tool on the processor.
   c. Release the tabs, and then carefully lift the processor and tool straight up.
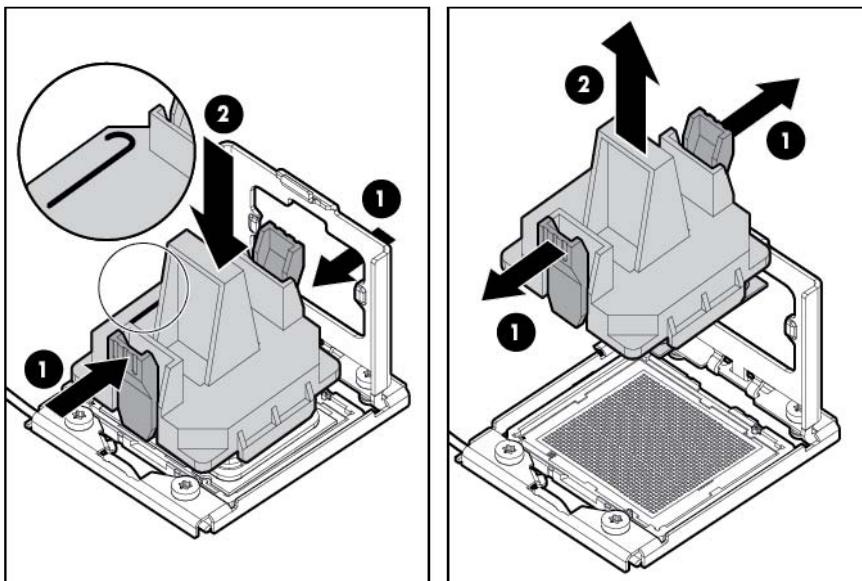
8. Carefully rotate the tool, and then push in and release the tabs to secure the processor in the tool.
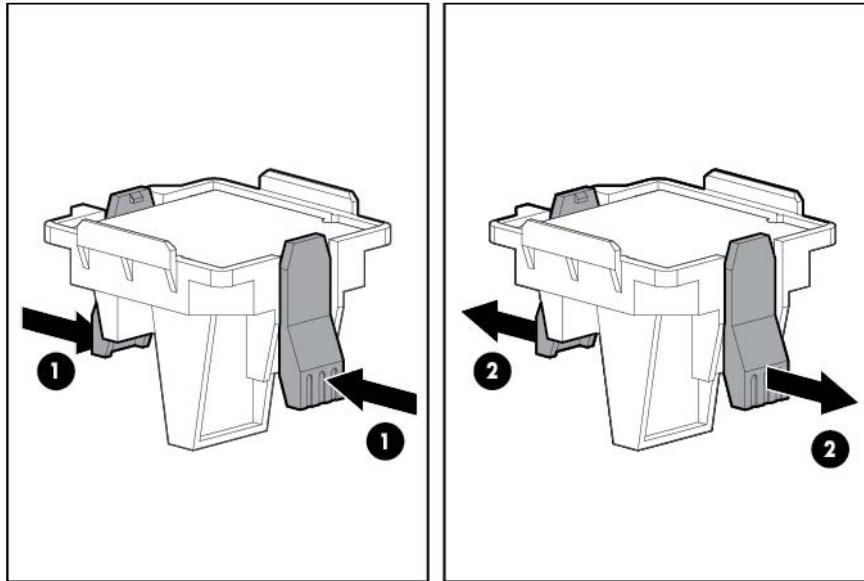
△ **CAUTION:** To avoid damage to the processor, do not touch the bottom of the processor, especially the contact area.

To replace the component:

1. Carefully insert the processor into the processor installation tool. Handle the processor by the edges only, and do not touch the bottom of the processor, especially the contact area.
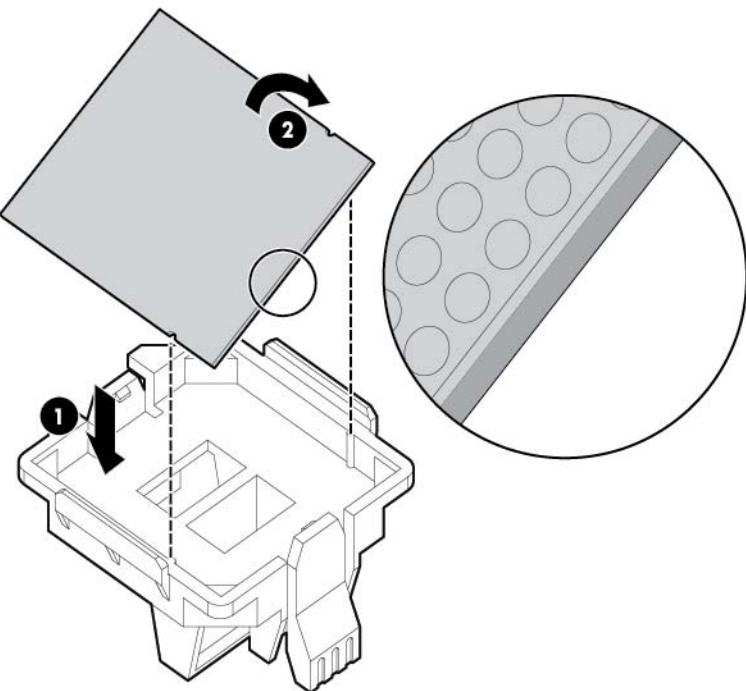
2. Be sure the tool is oriented correctly. Align the processor installation tool with the socket, and then install the processor. **THE PINS ON THE SYSTEM BOARD ARE VERY FRAGILE AND EASILY DAMAGED**.
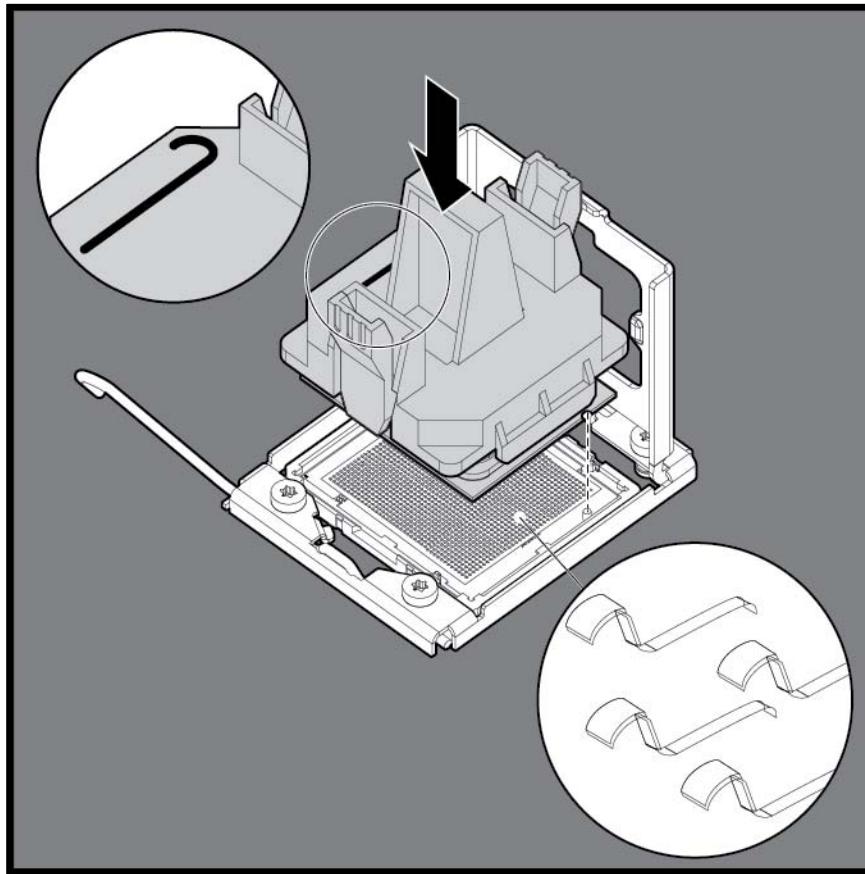
⚠ **CAUTION:** **THE PINS ON THE SYSTEM BOARD ARE VERY FRAGILE AND EASILY DAMAGED.** To avoid damage to the system board:

- Never install or remove a processor without using the processor installation tool.
- Do not touch the processor socket contacts.
- Do not tilt or slide the processor when lowering the processor into the socket.

3. Press and hold the tabs on the processor installation tool to separate it from the processor, and then remove the tool.
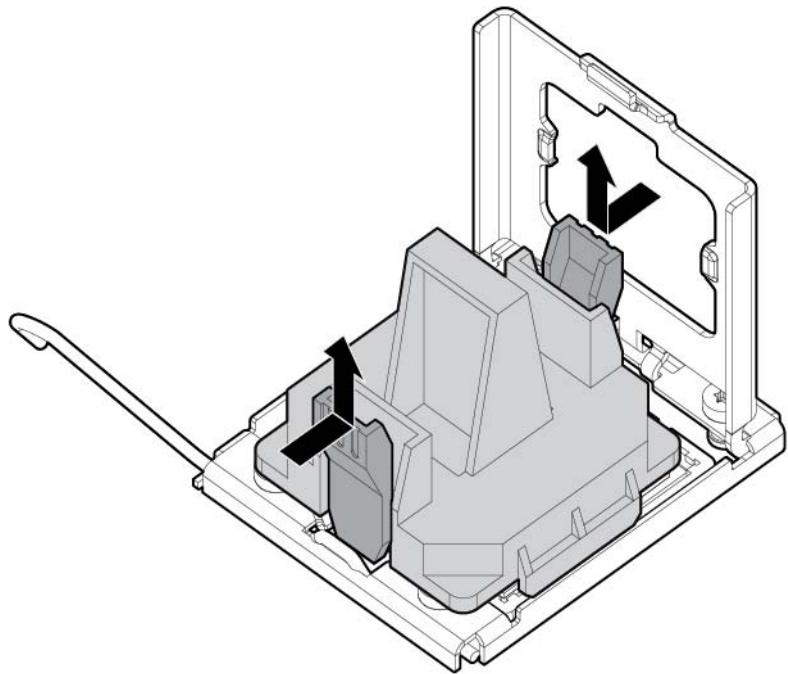
4. Close the processor socket retaining bracket and the processor locking lever.

△ **CAUTION:** Be sure to close the processor socket retaining bracket before closing the processor locking lever. The lever should close without resistance. Forcing the lever closed can damage the processor and socket, requiring system board replacement.
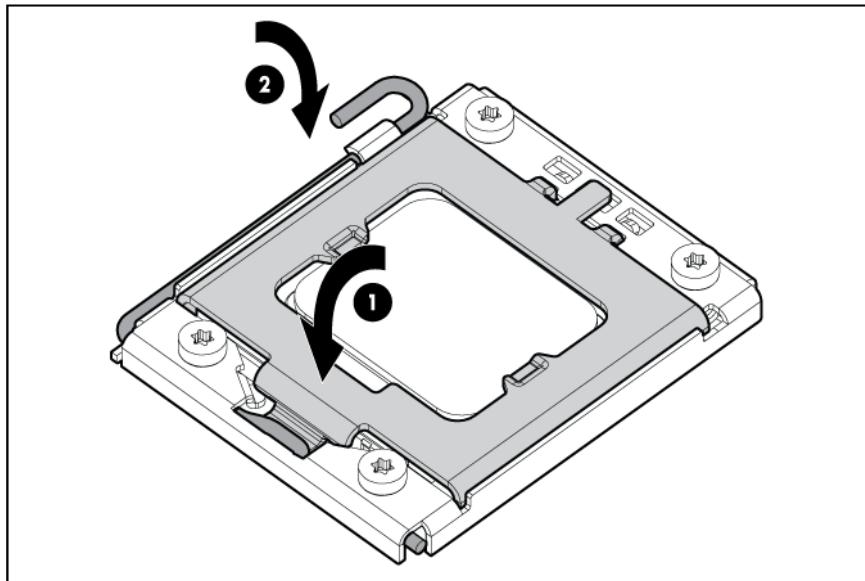
5. Install the heatsink.
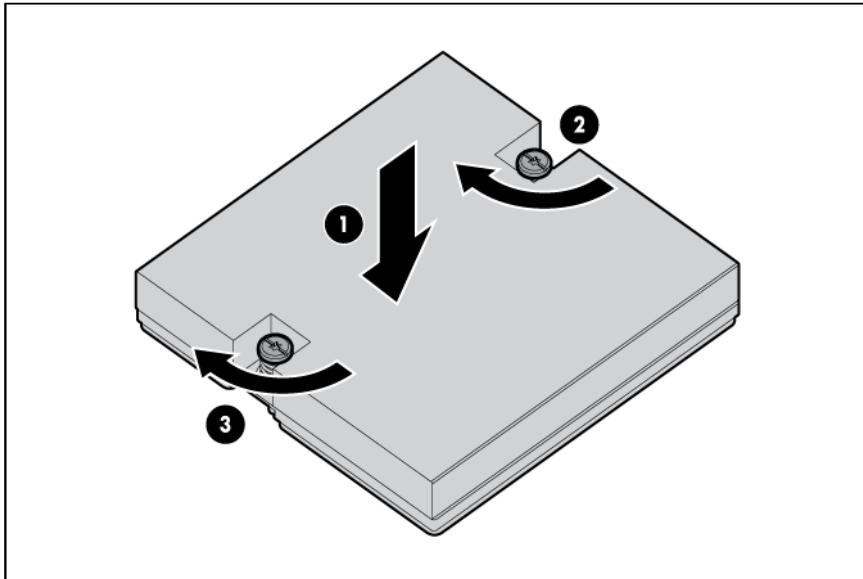
6. Install the air baffle ("Air baffle" on page 28).

7. Install the access panel ("Access panel" on page 27).

System board

To remove the component:

1. Power down the server (on page 25).

2. Remove the server from the rack (on page 26).

3. Remove the access panel ("Access panel" on page 27).

4. Remove the air baffle ("Air baffle" on page 28).

5. Remove the PCI riser board assembly ("PCI riser board assembly" on page 42).

6. Remove all DIMMs ("DIMMs" on page 49).

7. Disconnect all cables from the system board.

8. Remove the dedicated iLO connector module, if installed ("Dedicated iLO 2 connector module" on page 49).

9. Remove the heatsink ("Heatsink" on page 50).

10. Open the processor locking lever and the processor socket retaining bracket.
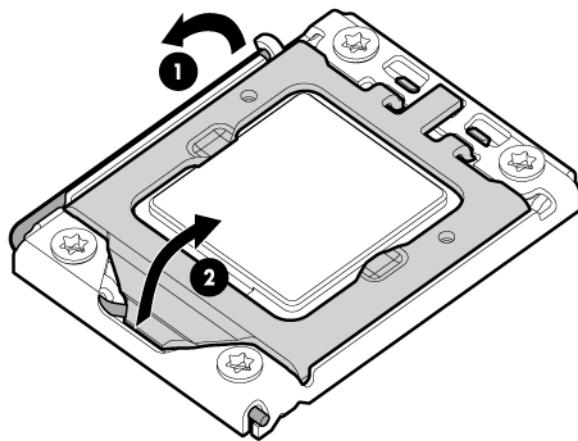
11. Using the processor tool, remove the processor from the system board:

   a. Line up the processor tool, ensuring the locking lever graphic on the tool is oriented correctly.

   b. Press in on the plastic tabs, and then place the tool on the processor.

   c. Release the tabs, and then carefully lift the processor and tool straight up.
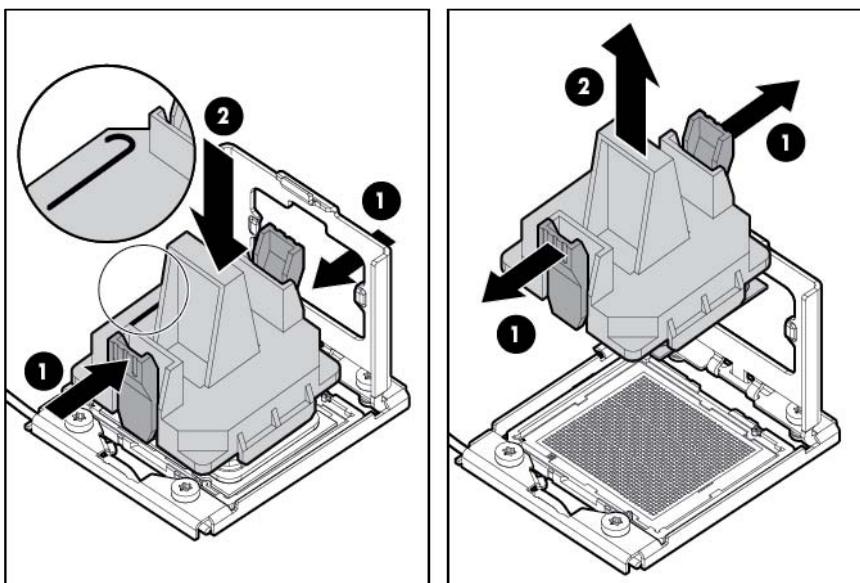
12. Carefully rotate the tool, and then push in and release the tabs to secure the processor in the tool.
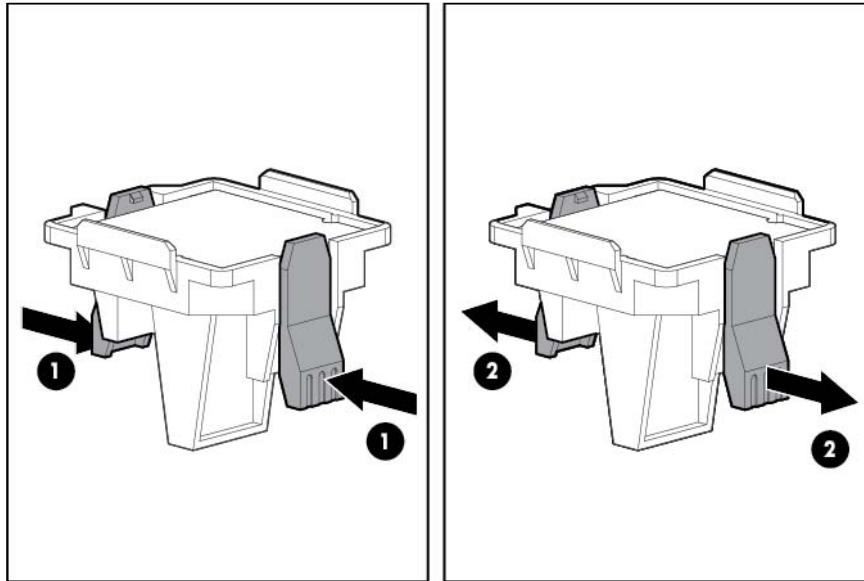
⚠ **CAUTION:** To avoid damage to the processor, do not touch the bottom of the processor, especially the contact area.

⚠ **CAUTION:** To avoid damage to the system board:
- Do not touch the processor socket contacts.
- Always install the processor socket cover after removing the processor from the socket.
- Do not tilt or slide the processor when lowering the processor into the socket.

13. Remove the eleven T-15 screws securing the failed system board.
14. Remove the failed system board.
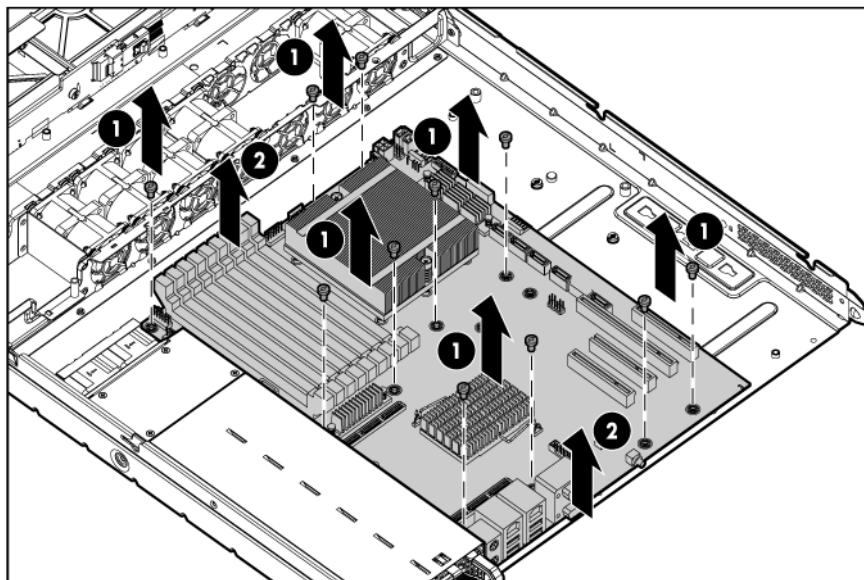
To replace the system board:

1. Install the spare system board in the server.

⚠ **CAUTION:** Failure to completely open the processor locking lever prevents the processor from seating during installation, leading to hardware damage.

2. Open the processor locking lever and the processor socket retaining bracket. **Do not remove the processor socket cover**.
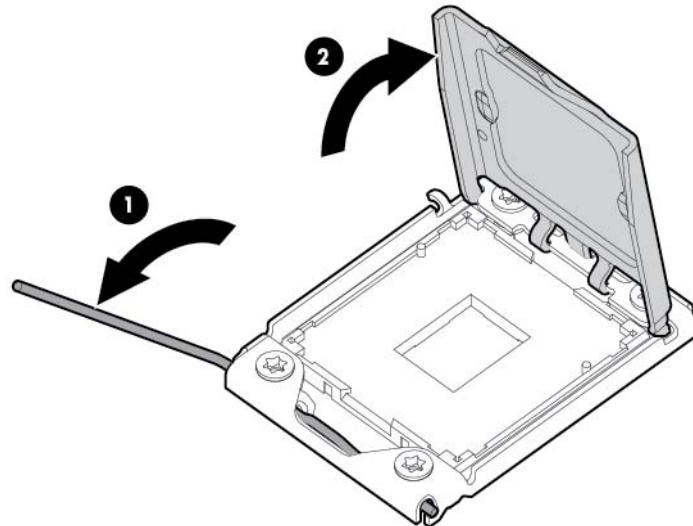
IMPORTANT: Be sure the processor remains inside the processor installation tool.

3. If the processor has separated from the installation tool, carefully re-insert the processor in the tool. Handle the processor by the edges only, and do not touch the bottom of the processor, especially the contact area.
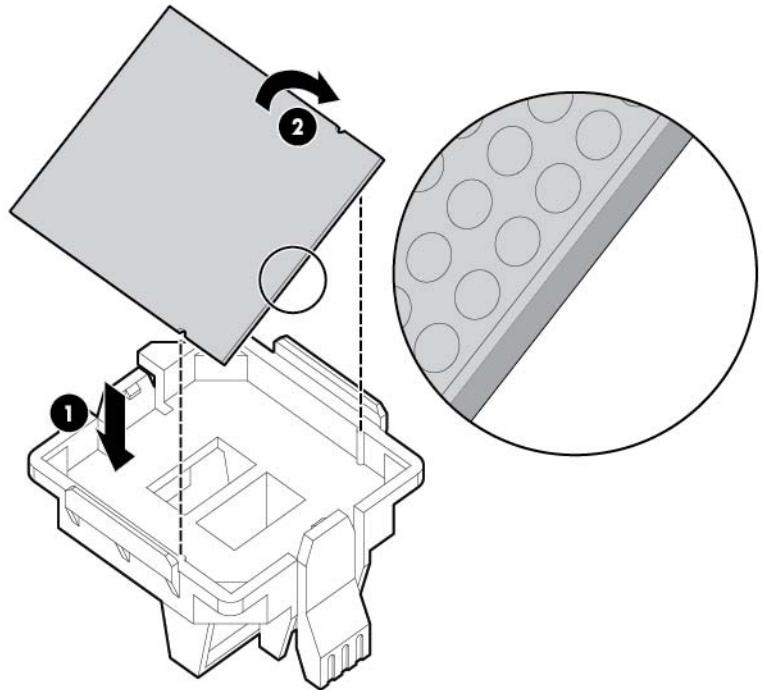
4. Align the processor installation tool with the socket, and then install the processor. **THE PINS ON THE SYSTEM BOARD ARE VERY FRAGILE AND EASILY DAMAGED**.
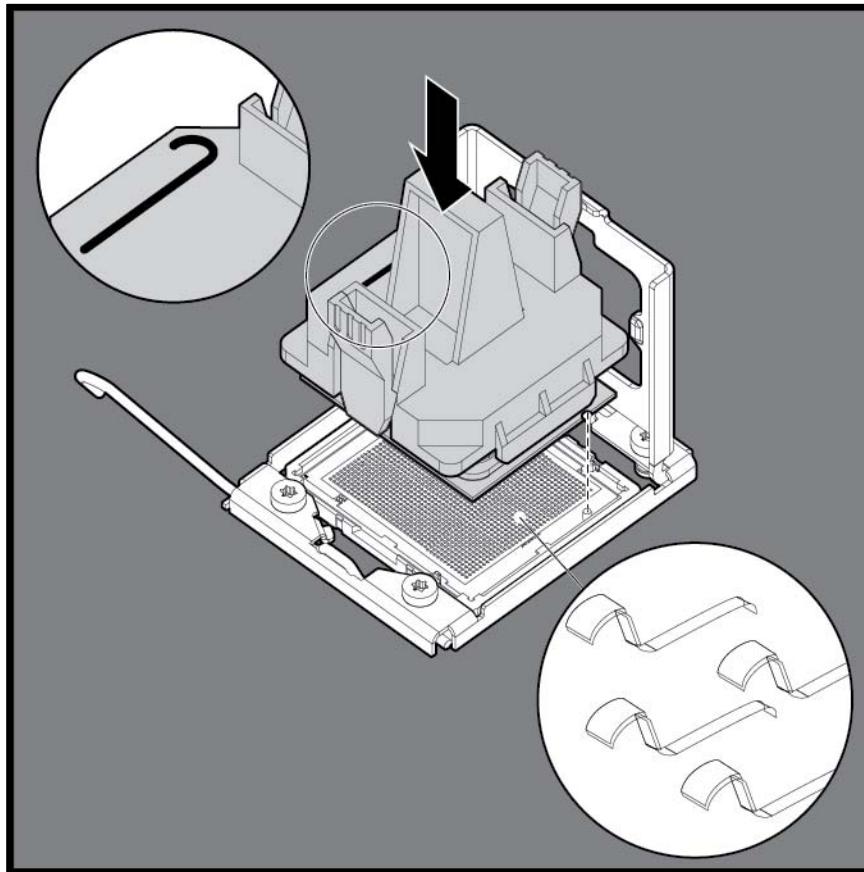

⚠ **CAUTION:** **THE PINS ON THE SYSTEM BOARD ARE VERY FRAGILE AND EASILY DAMAGED.** To avoid damage to the system board:

- Never install or remove a processor without using the processor installation tool.
- Do not touch the processor socket contacts.
- Do not tilt or slide the processor when lowering the processor into the socket.

5. Press the tabs on the processor installation tool to separate it from the processor, and then remove the tool.
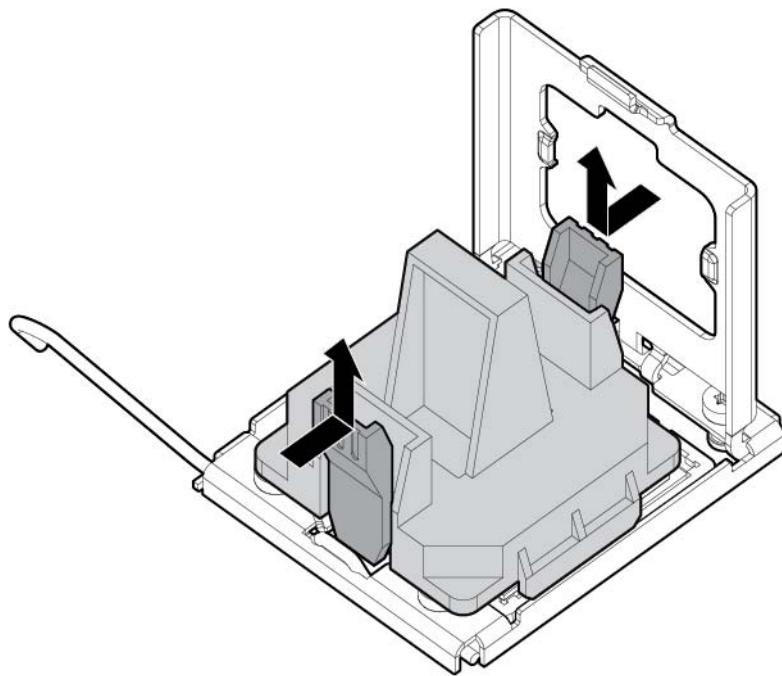
6. Close the processor socket retaining bracket and the processor locking lever. **The processor socket cover is automatically ejected**. Remove the cover.
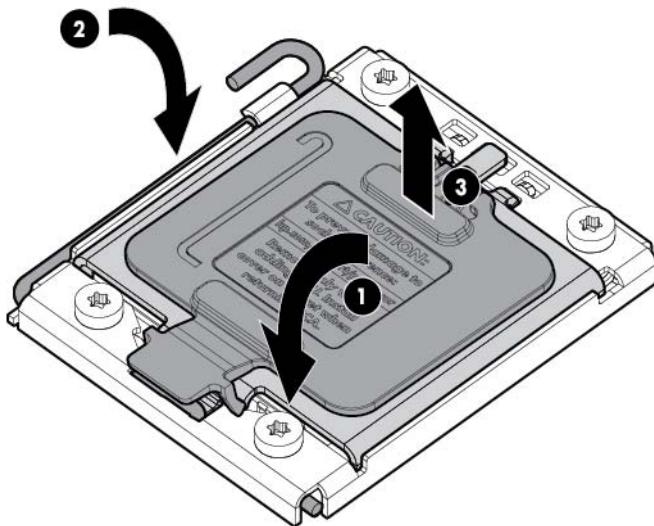

⚠ **CAUTION:** Be sure to close the processor socket retaining bracket before closing the processor locking lever. The lever should close without resistance. Forcing the lever closed can damage the processor and socket, requiring system board replacement.

7. Install the processor socket cover onto the processor socket of the failed system board.

8. Clean the old thermal grease from the heatsink and the top of the processor with the alcohol swab. Allow the alcohol to evaporate before continuing.

9. Apply all the grease to the top of the processor in the following pattern to ensure even distribution.
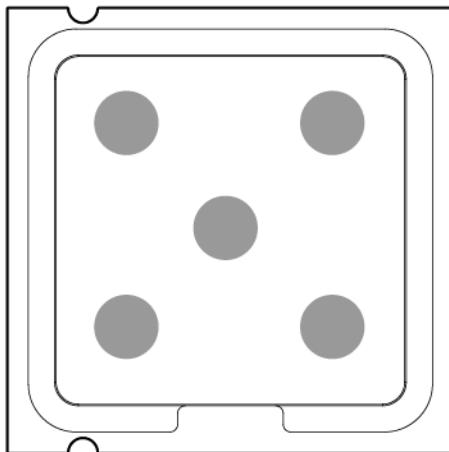
10. Align and install the heatsink. Alternate tightening the screws until the heatsink is seated properly.
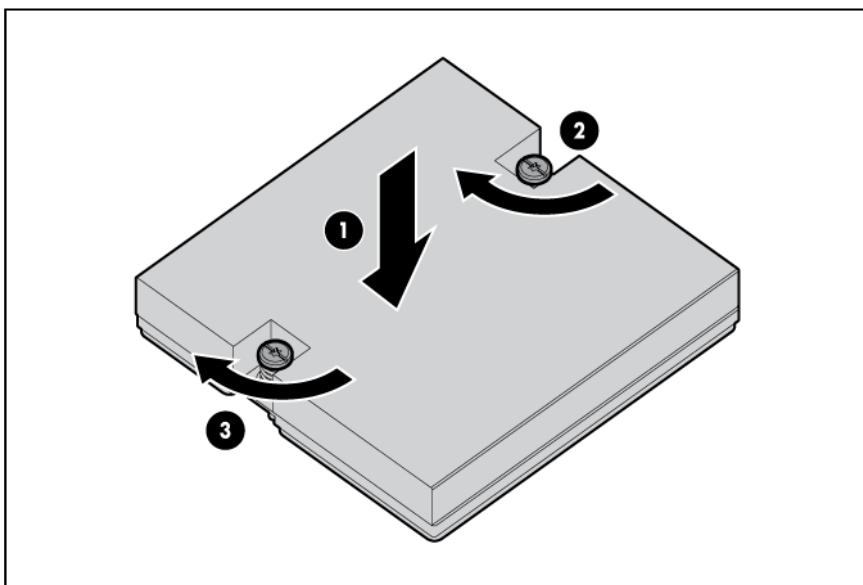
> **IMPORTANT:** To ensure proper cooling, be sure the processor air baffle is installed at all times (if applicable).

11. Install all components removed from the failed system board.

> **IMPORTANT:** Install all components with the same configuration that was used on the failed system board.

12. Install the access panel ("Access panel" on page 27).
13. Install the server in the rack.
14. Power up the server.

After you replace the system board, you must re-enter the server serial number and the product ID.

1. During the server startup sequence, press the **F9** key to access RBSU.
2. Select the **Advanced Options** menu.
3. Select **Serial Number**. The following warning is displayed:

```
Warning: The serial number should ONLY be modified by qualified service
personnel. This value should always match the serial number located on the
chassis.
```

4. Press the **Enter** key to clear the warning.

5. Enter the serial number.

6. Select **Product ID**. The following warning is displayed.

```
Warning: The Product ID should ONLY be modified by qualified service
personnel. This value should always match the Product ID located on the
chassis.
```

7. Enter the product ID and press the **Enter** key.

8. Press the **Esc** key to close the menu.

9. Press the **Esc** key to exit RBSU.

10. Press the **F10** key to confirm exiting RBSU. The server will automatically reboot.

Battery

⚠ **WARNING:** The computer contains an internal lithium manganese dioxide, a vanadium pentoxide, or an alkaline battery pack. A risk of fire and burns exists if the battery pack is not properly handled. To reduce the risk of personal injury:

*   Do not attempt to recharge the battery.
*   Do not expose the battery to temperatures higher than 60°C (140°F).
*   Do not disassemble, crush, puncture, short external contacts, or dispose of in fire or water.
*   Replace only with the spare designated for this product.

If the server no longer automatically displays the correct date and time, you may need to replace the battery that provides power to the real-time clock. Under normal use, battery life is 5 to 10 years.

⚠ **CAUTION:** To prevent damage to the server, power down the server and remove all AC power cords before removing or installing the battery.

To remove the component:

1. Power down the server (on page 25).

2. Remove the server from the rack (on page 26).

3. Remove the access panel ("Access panel" on page 27).

4. Remove the air baffle ("Air baffle" on page 28).

5. Remove the battery.
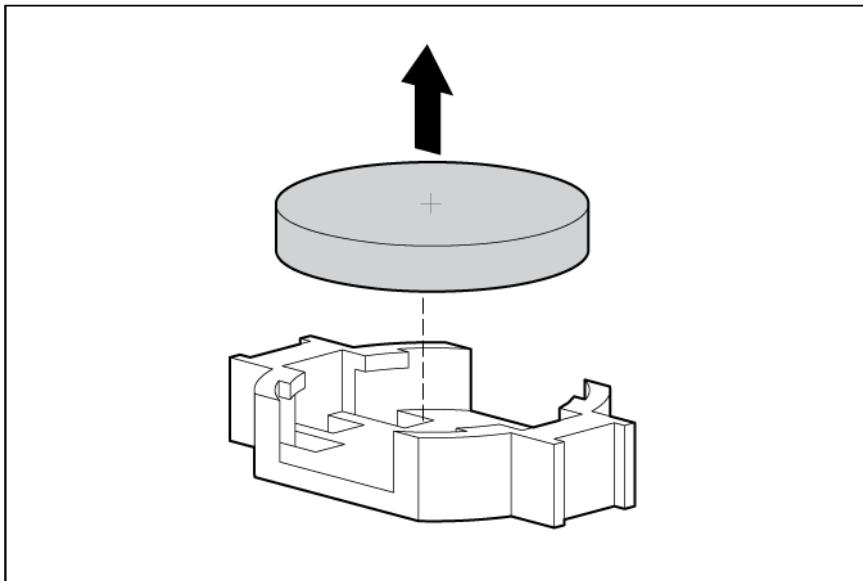
📝 **IMPORTANT:** Replacing the system board battery resets the system ROM to its default configuration. After replacing the battery, reconfigure the system through RBSU.

To replace the component, reverse the removal procedure.

For more information about battery replacement or proper disposal, contact an authorized reseller or an authorized service provider.

HP Trusted Platform Module

The TPM is not a customer-removable part.

⚠ **CAUTION:** Any attempt to remove an installed TPM from the system board breaks or disfigures the TPM security rivet. Upon locating a broken or disfigured rivet on an installed TPM, administrators should consider the system compromised and take appropriate measures to ensure the integrity of the system data.

If you suspect a TPM board failure, leave the TPM installed and remove the system board ("System board" on page 57). Contact an HP authorized service provider for a replacement system board and TPM board.

Diagnostic tools

Troubleshooting resources

The *HP ProLiant Servers Troubleshooting Guide* provides procedures for resolving common problems and comprehensive courses of action for fault isolation and identification, error message interpretation, issue resolution, and software maintenance on ProLiant servers and server blades. This guide includes problem-specific flowcharts to help you navigate complex troubleshooting processes. To view the guide, select a language:

- English (http://www.hp.com/support/ProLiant_TSG_en)
- French (http://www.hp.com/support/ProLiant_TSG_fr)
- Italian (http://www.hp.com/support/ProLiant_TSG_it)
- Spanish (http://www.hp.com/support/ProLiant_TSG_sp)
- German (http://www.hp.com/support/ProLiant_TSG_gr)
- Dutch (http://www.hp.com/support/ProLiant_TSG_nl)
- Japanese (http://www.hp.com/support/ProLiant_TSG_jp)

HP Insight Diagnostics

HP Insight Diagnostics is a proactive server management tool, available in both offline and online versions, that provides diagnostics and troubleshooting capabilities to assist IT administrators who verify server installations, troubleshoot problems, and perform repair validation.

HP Insight Diagnostics Offline Edition performs various in-depth system and component testing while the OS is not running. To run this utility, launch the SmartStart CD.

HP Insight Diagnostics Online Edition is a web-based application that captures system configuration and other related data needed for effective server management. Available in Microsoft® Windows® and Linux versions, the utility helps to ensure proper system operation.

For more information or to download the utility, refer to the HP website (http://www.hp.com/servers/diags).

HP Insight Diagnostics survey functionality

HP Insight Diagnostics (on page 67) provides survey functionality that gathers critical hardware and software information on ProLiant servers.

This functionality supports operating systems that may not be supported by the server. For operating systems supported by the server, see the HP website (http://www.hp.com/go/supportos).

If a significant change occurs between data-gathering intervals, the survey function marks the previous information and overwrites the survey data files to reflect the latest changes in the configuration.

Survey functionality is installed with every SmartStart-assisted HP Insight Diagnostics installation, or it can be installed through the HP PSP.

> **NOTE:**   The current version of SmartStart provides the memory spare part numbers for the server. To download the latest version, see the HP website (http://www.hp.com/support).

Integrated Management Log

The IML records hundreds of events and stores them in an easy-to-view form. The IML timestamps each event with 1-minute granularity.

You can view recorded events in the IML in several ways, including the following:

- From within HP SIM
- From within Survey Utility
- From within operating system-specific IML viewers
  - For NetWare: IML Viewer
  - For Windows®: IML Viewer
  - For Linux: IML Viewer Application
- From within the iLO 2 user interface
- From within HP Insight Diagnostics (on page 67)

For more information, see the Management CD in the HP Insight Foundation suite for ProLiant.

HP Insight Remote Support software

HP strongly recommends that you install HP Insight Remote Support software to complete the installation or upgrade of your product and to enable enhanced delivery of your HP Warranty, HP Care Pack Service, or HP contractual support agreement. HP Insight Remote Support supplements your monitoring 24 x 7 to ensure maximum system availability by providing intelligent event diagnosis, and automatic, secure submission of hardware event notifications to HP, which will initiate a fast and accurate resolution, based on your product's service level. Notifications may be sent to your authorized HP Channel Partner for on-site service, if configured and available in your country. The software is available in two variants:

- HP Insight Remote Support Standard: This software supports server and storage devices and is optimized for environments with 1–50 servers. Ideal for customers who can benefit from proactive notification but do not need proactive service delivery and integration with a management platform.
- HP Insight Remote Support Advanced: This software provides comprehensive remote monitoring and proactive service support for nearly all HP servers, storage, network, and SAN environments, plus selected non-HP servers that have a support obligation with HP. It is integrated with HP Systems Insight Manager. A dedicated server is recommended to host both HP Systems Insight Manager and HP Insight Remote Support Advanced.

Details for both versions are available on the HP website (http://www.hp.com/go/insightremotesupport).

To download the software, go to Software Depot (http://www.software.hp.com).

Select **Insight Remote Support** from the menu on the right.

USB support

HP provides both standard USB 2.0 support and legacy USB 2.0 support. Standard support is provided by the OS through the appropriate USB device drivers. Before the OS loads, HP provides support for USB devices through legacy USB support, which is enabled by default in the system ROM.

Legacy USB support provides USB functionality in environments where USB support is not available normally. Specifically, HP provides legacy USB functionality for the following:

- POST
- RBSU
- Diagnostics
- DOS
- Operating environments which do not provide native USB support

Component identification

Front panel components

- LFF models
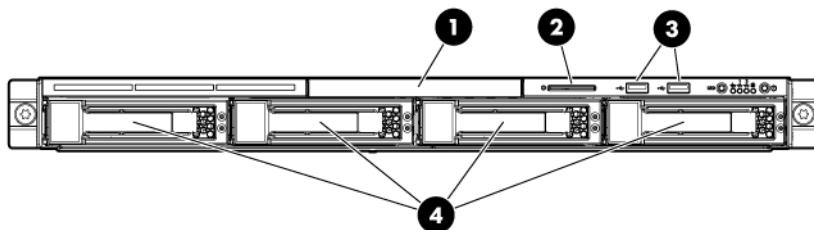
Item	Description
1	Optical drive blank
2	Serial label pull tab
3	USB connectors (2)
4	Hard drive bays

- SFF models
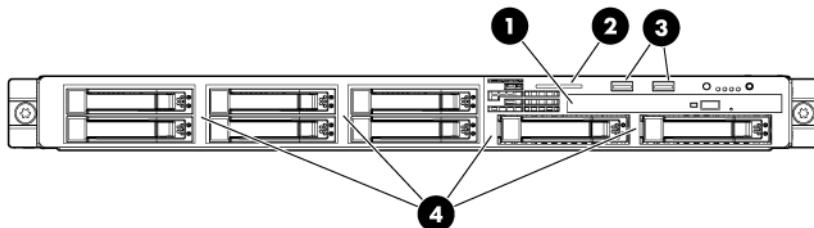
Item	Description
1	Optical drive blank
2	Serial label pull tab
3	USB connectors (2)
4	Hard drive bays

Front panel LEDs and buttons

Item	Description	Status
1	Internal health LED	Green = System health is normal. Amber = System health is degraded. To identify the component in a degraded state, see "System board LEDs (on page 77)." Red = System health is critical. To identify the component in a critical state, see "System board LEDs (on page 77)." Off = System health is normal (when in standby mode).
2	NIC 1 link/activity LED	Green = Network link exists. Flashing green = Network link and activity exist. Off = No network link exists. If power is off, view the LEDs on the RJ-45 connector. See "Rear panel LEDs and buttons (on page 73)."
3	NIC 2 link/activity LED	Green = Network link exists. Flashing green = Network link and activity exist. Off = No network link exists. If power is off, view the LEDs on the RJ-45 connector. See "Rear panel LEDs and buttons (on page 73)."
4	Drive activity LED	Green = Drive activity is normal. Off = No drive activity exists.
5	Power On/Standby button and system power LED	Green = Normal (system on) Amber = System is in standby, but power is still applied. Off = Power cord is not attached or the power supply has failed.
6	UID button/LED	Blue = Identification is activated. Flashing blue = System is being managed remotely. Off = Identification is deactivated.

System LEDs and internal health LED combinations

When the internal health LED on the front panel illuminates either amber or red, the server is experiencing a health event. Combinations of illuminated system LEDs and the internal health LED indicate system status.

The front panel health LEDs indicate only the current hardware status. In some situations, HP SIM may report server status differently than the health LEDs because the software tracks more system attributes.

System LED and Color	Internal Health LED Color	Status
Processor failure (amber)	Red	One or more of the following conditions may exist: • Processor has failed. • Processor is not installed in the socket. • Processor is unsupported. • ROM detects a failed processor during POST.
	Amber	Processor is in a pre-failure condition.
DIMM failure, slot *X* (amber)	Red	• DIMM in slot *X* has failed. • DIMM in slot *X* is an unsupported type, and no valid memory exists in another channel.
	Amber	• DIMM in slot *X* has reached the single-bit correctable error threshold. • DIMM in slot *X* is in a pre-failure condition. • DIMM in slot *X* is an unsupported type, but valid memory exists in another channel.
DIMM failure, all slots in one channel (amber)	Red	No valid or usable memory is installed in the system.
	Amber	• The entire channel is not populated. • DIMMs do not match within the channel, but other valid memory is available.
Overtemperature (amber)	Amber	The Health Driver has detected a cautionary temperature level.
	Red	The server has detected a hardware critical temperature level.
Fan module (amber)	Red	The minimum fan requirements are not being met in one or more of the fan modules. One or more fans have failed or are missing.
Power supply (amber)	Red	One or more of the following conditions may exist: • There is no AC power. • The power supply has failed.
	Amber	There is a power supply mismatch at POST.

SAS and SATA device numbers
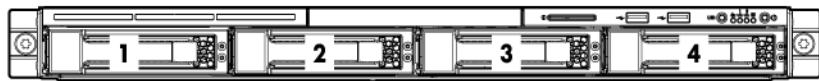
Rear panel components

For this server model, PCI expansion slots 1-3 and 6 are reserved.
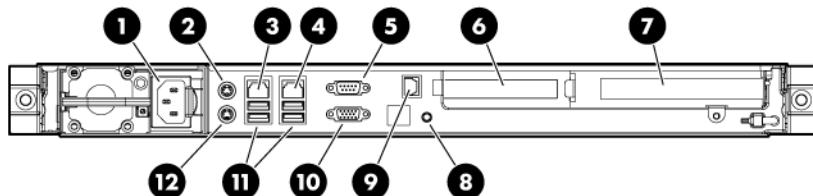
Item	Description
1	Power cord connector
2	Mouse connector
3	10/100/1000 NIC 1 connector/shared iLO 2 management port
4	10/100/1000 NIC 2 connector
5	Serial connector
6	Slot 5 PCIe2 x16 (4, 2, 1)
7	Slot 4 PCIe2 x16 (16, 8, 4, 1)
8	UID button/LED
9	Dedicated iLO 2 management port (optional)
10	Video connector
11	USB connectors (2)
12	Keyboard connector

Rear panel LEDs and buttons
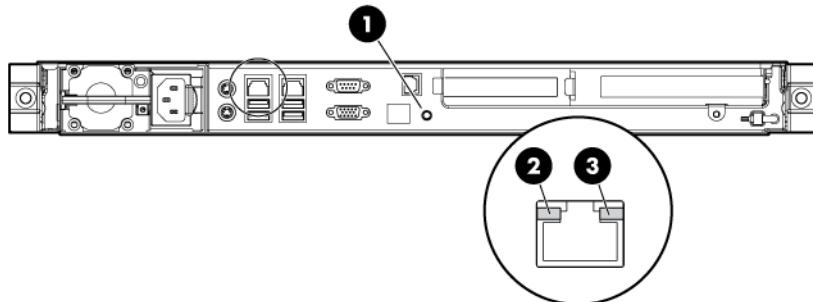
Item	Description	Status
1	UID button/LED	Blue = Activated Flashing = System is being managed remotely. Off = Deactivated
2	NIC/iLO 2 link	Green or flashing green = Activity exists. Off = No activity exists.
3	NIC/iLO 2 activity	Green = Link exists. Off = No link exists.

PCI expansion slot definitions

For this server model, PCI expansion slots 1-3 and 6 are reserved.

Slot	Type	Length	Connector	Interconnect
4	PCI Express	Full	x16	x16
4	Optional PCI-X	Full	133 MHz/3.3 V	64 bit
5	PCI Express	Half	x16	x4

System board components

For this server, some system board slots and connectors are reserved.
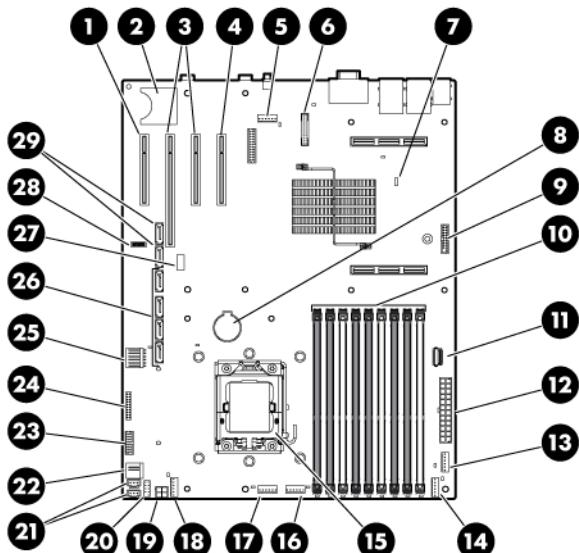
Item	Description
1	Reserved
2	SD card connector
3	PCIe riser board connectors
4	Reserved
5	Fan 6 connector (reserved)
6	Dedicated iLO 2 module connector (optional)
7	NMI jumper

Item	Description
8	System battery
9	TPM connector
10	DIMM slots 1-9
11	Reserved
12	System power connector
13	Fan 1 connector
14	Fan 2 connector
15	Processor socket
16	Fan 3 connector
17	Fan 4 connector
18	Fan 5 connector*
19	Power connector
20	Front USB connector
21	Hard drive backplane connector
22	USB tape drive connector
23	Redundant power supply connector
24	Front panel connector
25	Fan 7 connector
26	SATA connectors 1-4 (hard drives)
27	Hard drive backplane connector
28	System maintenance switch
29	SATA connectors 5-6 (optical drives)**

* The fan in slot 5 is only available in CTO models of this server.
**The server supports one optical drive that can be connected to either SATA connector 5 or SATA connector 6.

System maintenance switch

Position	Default	Function
S1	Off	Off = iLO 2 security is enabled. On = iLO 2 security is disabled.
S2	Off	Off = Normal operation On = RBSU will not commit any configuration changes.*
S3	Off	Reserved
S4	Off	Reserved
S5	Off	Off = Power-on password enabled On = Power-on password disabled*
S6	Off	Off = Normal operation On = BIOS will clear CMOS and NVRAM.*
S7	Off	Reserved

Position	Default	Function
S8	Off	Reserved

* "On" activates the function.

NMI functionality

An NMI crash dump enables administrators to create crash dump files when a system is hung and not responding to traditional debug mechanisms.

Crash dump log analysis is an essential part of diagnosing reliability problems, such as hangs in operating systems, device drivers, and applications. Many crashes freeze a system, and the only available action for administrators is to cycle the system power. Resetting the system erases any information that could support problem analysis, but the NMI feature preserves that information by performing a memory dump before a hard reset.

To force the OS to invoke the NMI handler and generate a crash dump log, the administrator can do any of the following:

- Short the NMI jumper pins
- Press the NMI switch
- Use the iLO Virtual NMI feature

For additional information, see the whitepaper on the HP website (http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00797875/c00797875.pdf).

DIMM identification

To determine DIMM characteristics, use the label attached to the DIMM and the following illustration and table.
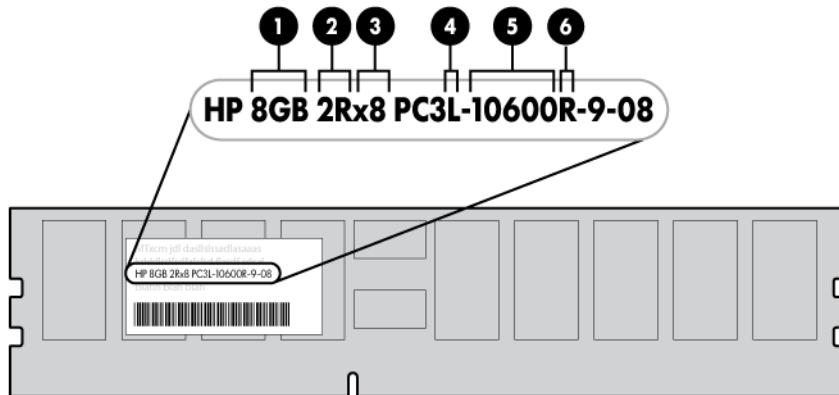
Item	Description	Definition
1	Size	—
2	Rank	1R = Single-rank 2R = Dual-rank 4R = Quad-rank
3	Data width	x4 = 4-bit x8 = 8-bit
4	Voltage rating	L = Low voltage (1.35v) Blank or omitted = Standard
5	Memory speed	10600 = 1333-MHz 8500 = 1066-MHz
6	DIMM type	R = RDIMM (registered) E = UDIMM (unbuffered with ECC)

For the latest supported memory information, see the QuickSpecs on the HP website (http://www.hp.com).

System board LEDs
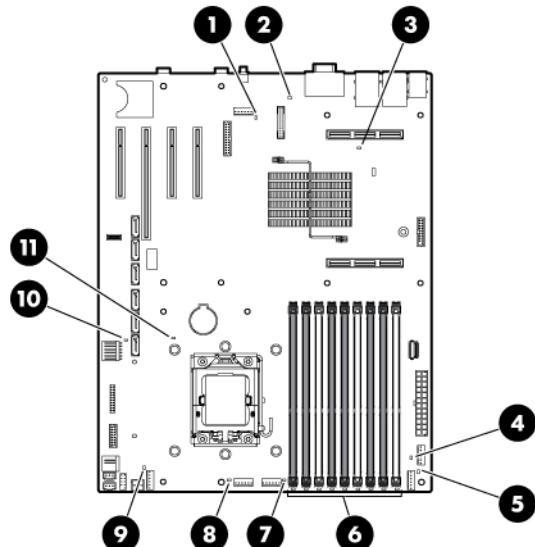
Item	LED description	Status
1	Fan 6 failure (reserved)	—
2	Power supply	Off = No AC power or failed power supply Green = Power supply is on and functioning.
3	Overtemperature	Amber = System has reached a cautionary or critical temperature level. Off = Normal
4	Fan 1 failure	Amber = Fan has failed or is missing. Off = Normal
5	Fan 2 failure	Amber = Fan has failed or is missing. Off = Normal

Item	LED description	Status
6	DIMM failure (1-9)	Amber = DIMM has failed or is missing. Off = Normal
7	Fan 3 failure	Amber = Fan has failed or is missing. Off = Normal
8	Fan 4 failure	Amber = Fan has failed or is missing. Off = Normal
9	Fan 5 failure*	Amber = Fan has failed or is missing. Off = Normal
10	Fan 7 failure	Amber = Fan has failed or is missing. Off = Normal
11	Processor failure	Amber = Processor has failed. Off = Normal

*The fan in slot 5 is only available in CTO models of this server.

Fan locations

The fan in slot 5 is only available in CTO models of this server.

Fan slot 6 is reserved.
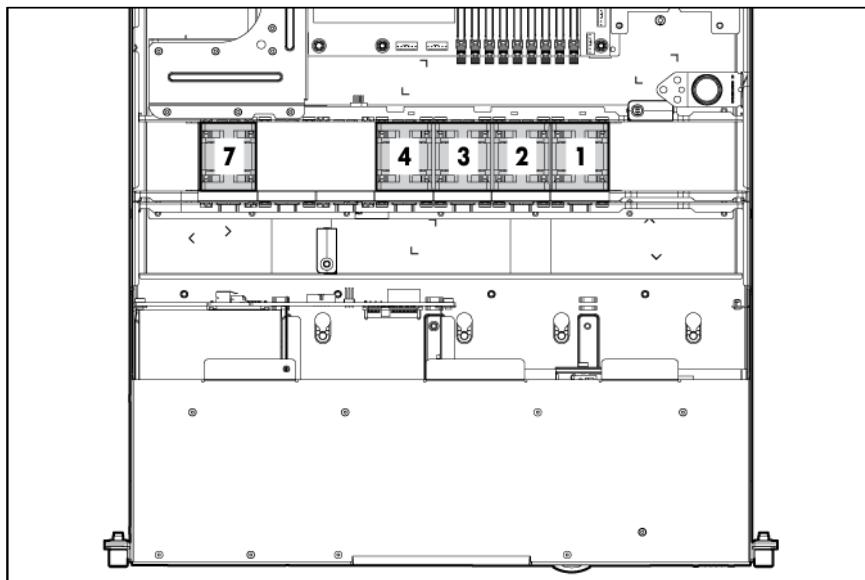
FBWC module LEDs

The FBWC module has two single-color LEDs (green and amber). The LEDs are duplicated on the reverse side of the cache module to facilitate status viewing.
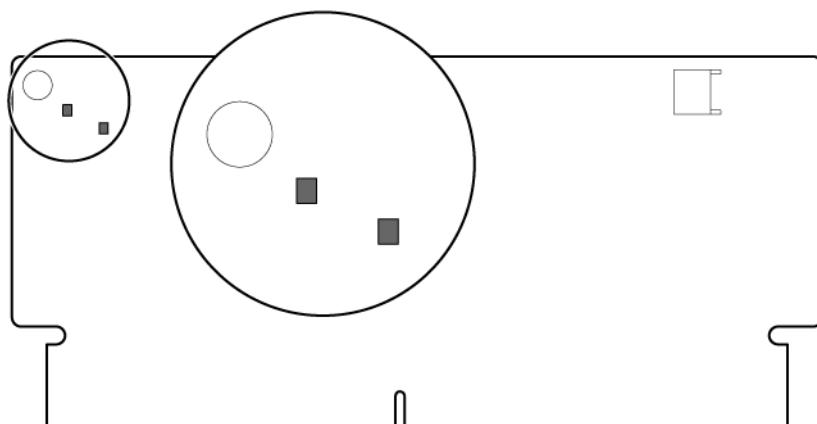
Green LED	Amber LED	Interpretation
Off	On	A backup is in progress.
Flashing (1 Hz)	On	A restore is in progress.
Flashing (1 Hz)	Off	The capacitor pack is charging.
On	Off	The capacitor pack has completed charging.
Flashing (2 Hz) Alternating with amber LED	Flashing (2 Hz) Alternating with green LED	One of the following conditions exists: • The charging process has timed out. • The capacitor pack is not connected.
On	On	The flash code image failed to load.
Off	Off	The flash code is corrupt.

Cabling

Cabling overview

This section provides guidelines that help you make informed decisions about cabling the server and hardware options to optimize performance.

Non-redundant power supply cabling

⚠️ **CAUTION:** When routing cables, always be sure that the cables are not in a position where they can be pinched or air flow can be blocked.

📝 **IMPORTANT:** Route the cables without blocking the airflow or other installed components. Use the cable clips installed in the chassis to manage cable routing.
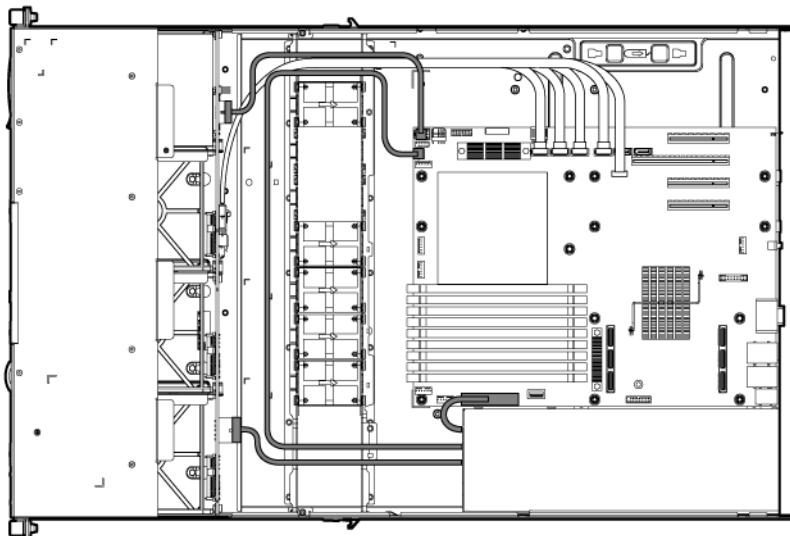

Optional non-redundant high-efficiency power supply cabling

⚠️ **CAUTION:** When routing cables, always be sure that the cables are not in a position where they can be pinched or air flow can be blocked.

📝 **IMPORTANT:** Route the cables without blocking the airflow or other installed components. Use the cable clips installed in the chassis to manage cable routing.
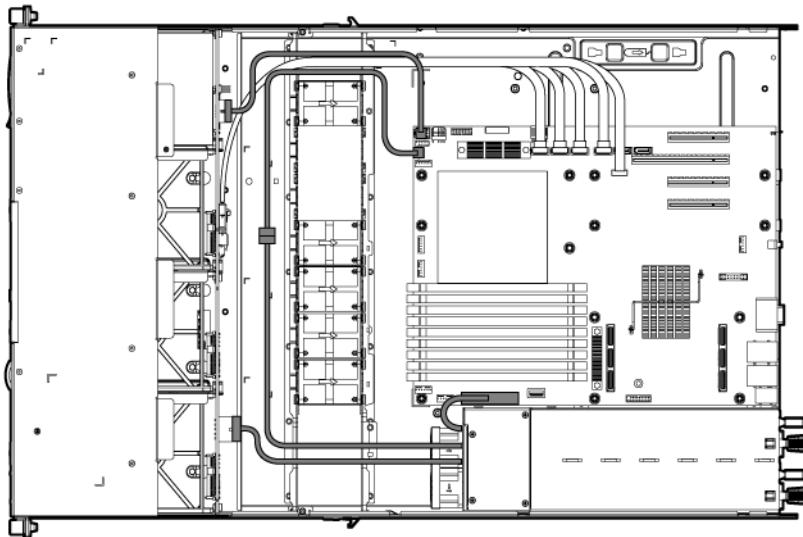
Optional redundant power supply cabling

⚠ **CAUTION:** When routing cables, always be sure that the cables are not in a position where they can be pinched or air flow can be blocked.

📝 **IMPORTANT:** Route the cables without blocking the airflow or other installed components. Use the cable clips installed in the chassis to manage cable routing.
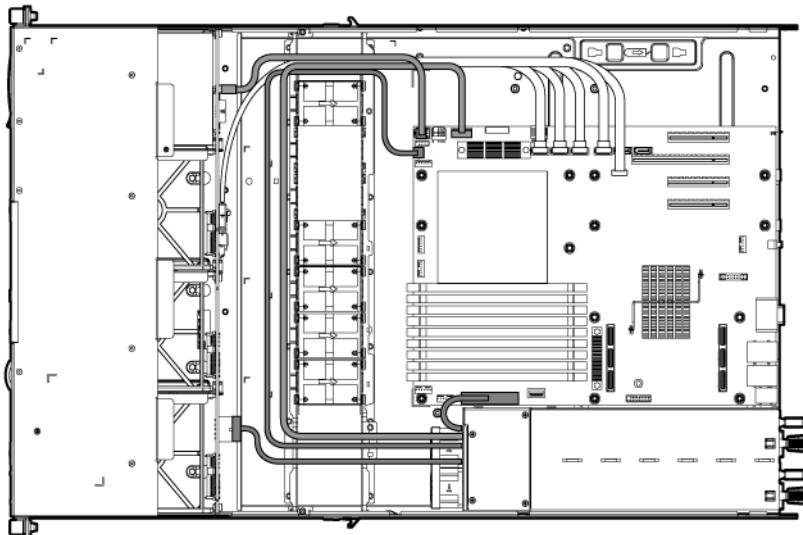
Optional common slot power supply cabling

⚠ **CAUTION:** When routing cables, always be sure that the cables are not in a position where they can be pinched or air flow can be blocked.

> **IMPORTANT:** Route the cables without blocking the airflow or other installed components. Use the cable clips installed in the chassis to manage cable routing.
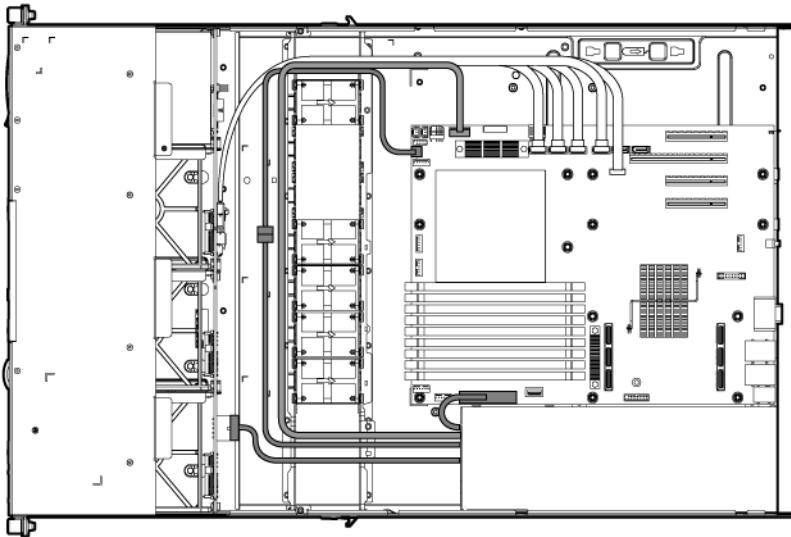
SATA cabling

> **CAUTION:** When routing cables, always be sure that the cables are not in a position where they can be pinched or air flow can be blocked.

> **IMPORTANT:** Route the cables without blocking the airflow or other installed components. Use the cable clips installed in the chassis to manage cable routing.
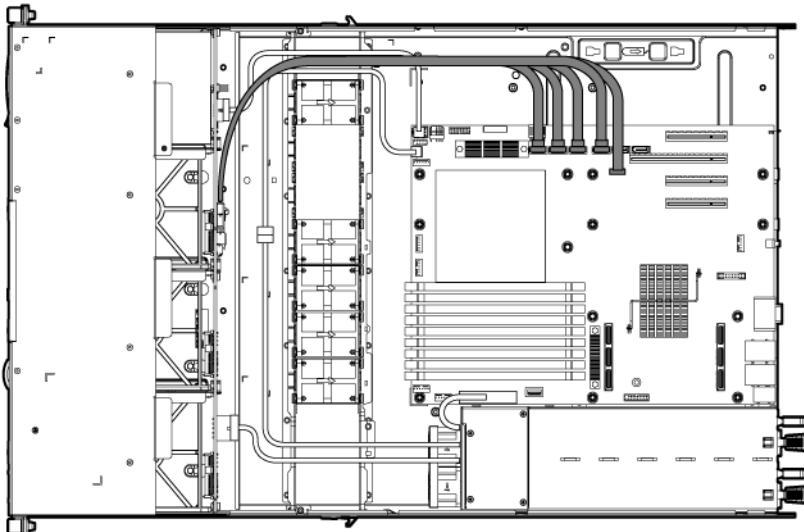
Optional SAS cabling

△ **CAUTION:**   When routing cables, always be sure that the cables are not in a position where they can be pinched or air flow can be blocked.

📝 **IMPORTANT:**   Route the cables without blocking the airflow or other installed components. Use the cable clips installed in the chassis to manage cable routing.
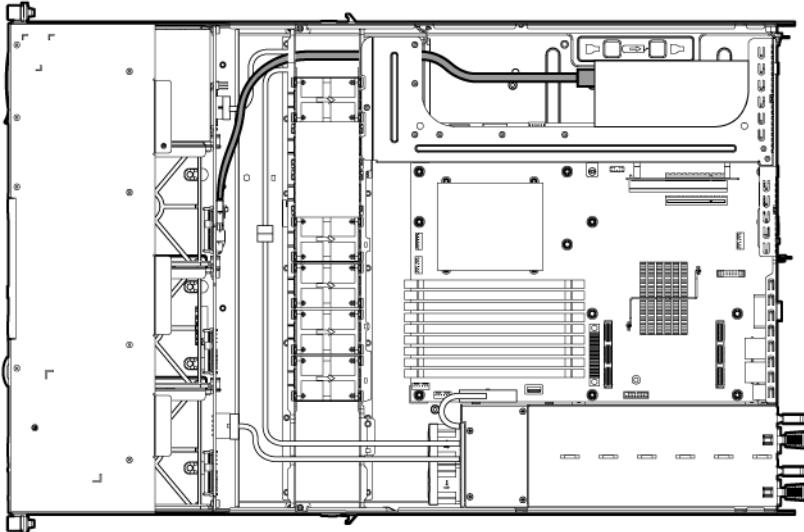
BBWC battery pack or FBWC capacitor pack cabling to an optional controller
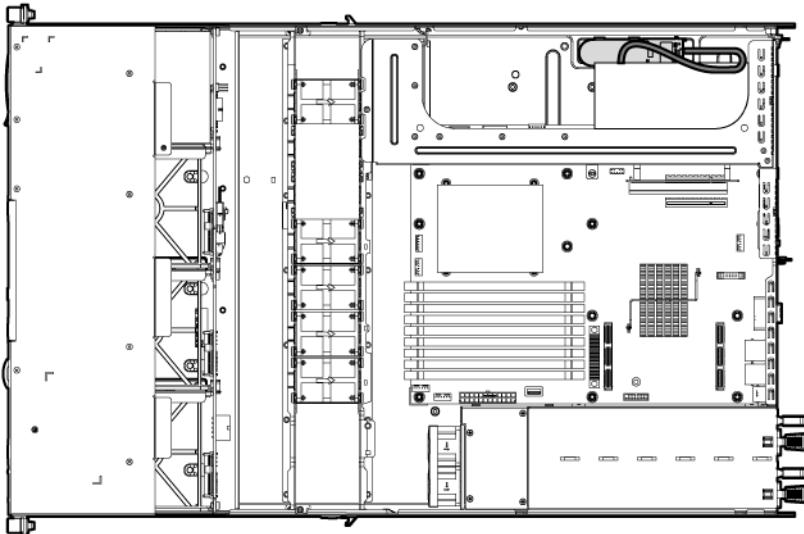
Specifications

Environmental specifications

Specification	Value
Temperature	
Operating[1]	10°C to 35°C (50°F to 90°F)
Non-operating	30°C to 60°C (-22°F to 140°F)
Maximum rate of temperature change	
Operating [2,3]	10°C/hr (18°F/hr)
Non-operating	20°C/hr (36°F/hr)
Relative humidity (noncondensing)	
Operating	10% to 90%
Non-operating	5% to 95%
Maximum wet bulb temperature (non-condensing)	
Operating	28°C (82.4°F)
Non-operating	38.7°C (101.7°F)
Altitude	
Operating[2]	3,050 m (10,000 ft)
Non-operating	9144 m (30,000 ft)
Maximum rate of altitude change	
Operating	457 m/min (1,500 ft/min)
Non-operating	457 m/min (1,500 ft/min)

[1] All temperature ratings shown are for sea level. An altitude derating of 1°C per 300 m (1.8°F per 1,000 ft) to 3048 m (10,000 ft) is applicable. No direct sunlight allowed.
[2] The type and number of options installed can limit the upper limit.
[3] System performance may be reduced if operating with a fan fault above 30°C (86°F).

Mechanical specifications

Specification	Value
Dimensions	
Height	4.32 cm (1.69 in)
Depth	70.00 cm (27.56 in)
Width	44.81 cm (17.64 in)

Specification	Value
Weight (maximum configuration: all hard drives, power supplies, and processors installed)	13.60 kg (29.98 lb)
Weight (minimum configuration: one hard drive, power supply, and processor installed)	11.60 kg (25.57 lb)

Power supply specifications

Depending on installed options, the server is configured with one of the following power supplies:

- HP ProLiant 400 W Power Supply

Specification	Value
Input requirements	
Rated input voltage	100 to 120 VAC, 200 to 240 VAC
Rated input frequency	50 Hz to 60 Hz
Rated input current	6 A at 100 VAC 3 A at 200 VAC
Rated input power	572 W at 100V AC input 572 W at 200V AC input
BTUs per hour	1952 at 120V AC input 1952 at 200V to 240V AC input
Power supply output	
Rated steady-state power	400 W at 100V to 120V AC input 430 W at 200V to 240V AC input
Maximum peak power	400 W at 100V to 120V AC input 430 W at 200V to 240V AC input

- HP ProLiant 400 W Redundant Power Supply

Specification	Value
Input requirements	
Rated input voltage	100 to 120 VAC, 200 to 240 VAC
Rated input frequency	50 Hz to 60 Hz
Rated input current	6 A at 100 VAC 3 A at 200 VAC
Rated input power	450 W at 100V AC input 420 W at 200V AC input
BTUs per hour	1708 at 100V AC input 1640 at 200V AC input
Power supply output	
Rated steady-state power	340 W at 100V to 120V AC input 340 W at 200V to 240V AC input

Maximum peak power	340 W at 100V to 120V AC input 340 W at 200V to 240V AC input

- HP ProLiant 460 W Power Supply

Specification	Value
Input requirements	
Rated input voltage	100 to 120 VAC, 200 to 240 VAC
Rated input frequency	50 Hz to 60 Hz
Rated input current	5.5 A at 100 VAC 2.6 A at 200 VAC
Rated input power	526 W at 100V AC input 505 W at 200V AC input
BTUs per hour	1794 at 100V AC input 1725 at 200V AC input
Power supply output	
Rated steady-state power	460 W at 100V to 120V AC input 460 W at 200V to 240V AC input
Maximum peak power	460 W at 100V to 120V AC input 460 W at 200V to 240V AC input

- HP ProLiant 500 W Power Supply

Specification	Value
Input requirements	
Rated input voltage	100 to 120 VAC, 200 to 240 VAC
Rated input frequency	50 Hz to 60 Hz
Rated input current	10 A at 100 VAC 5 A at 200 VAC
Rated input power	575 W at 100V AC input 575 W at 200V AC input
BTUs per hour	1962 at 120V AC input 1962 at 200V to 240V AC input
Power supply output	
Rated steady-state power	500 W at 100V to 120V AC input 500 W at 200V to 240V AC input
Maximum peak power	500 W at 100V to 120V AC input 500 W at 200V to 240V AC input

Acronyms and abbreviations

ADU

Array Diagnostics Utility

BBWC

battery-backed write cache

CSR

Customer Self Repair

DDR

double data rate

FBWC

flash-backed write cache

iLO

Integrated Lights-Out

IML

Integrated Management Log

LFF

large form-factor

MDL

midline

NCQ

native command queuing

NMI

non-maskable interrupt

NVRAM

non-volatile memory

PCIe

peripheral component interconnect express

PCI-X

peripheral component interconnect extended

POST

Power-On Self Test

RBSU

ROM-Based Setup Utility

RDIMM

Registered Dual In-line Memory Module

SAS

serial attached SCSI

SATA

serial ATA

SFF

small form-factor

SSD

solid-state drive

TPM

trusted platform module

UDIMM

Unregistered Dual In-Line Memory Module

UID

unit identification

USB

universal serial bus

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